

FEATURES

Low noise

Voltage noise = 2.2 nV/ $\sqrt{\text{Hz}}$

Current noise = 4.8 pA/ $\sqrt{\text{Hz}}$ (positive input)

Wide bandwidth (-3 dB) = 280 MHz

Nominal gain range: 0 dB to 24 dB (preamp gain = 6 dB)

Gain scaling: 19.7 dB/V

DC-coupled

Single-ended input and output

High speed uncommitted op amp input

Supplies: +5 V, ± 2.5 V, or ± 5 V

Low power: 78 mW with ± 2.5 V supplies

APPLICATIONS

Gain trim

PET scanners

High performance AGC systems

I/Q signal processing

Video

Industrial and medical ultrasound

Radar receivers

GENERAL DESCRIPTION

The AD8337 is a low noise, single-ended, linear-in-dB, general-purpose variable gain amplifier (VGA) usable at frequencies from dc to 100 MHz; the -3 dB bandwidth is 280 MHz.

Excellent bandwidth uniformity across the entire gain range and low output-referred noise makes the AD8337 ideal for gain trim applications and for driving high speed analog-to-digital converters (ADCs).

Excellent dc characteristics combined with high speed make the AD8337 particularly suited for industrial ultrasound, PET scanners, and video applications. Dual-supply operation enables gain control of negative-going pulses, such as those generated by photodiodes or photomultiplier tubes.

The AD8337 uses the popular and versatile X-AMP[®] architecture, exclusively from Analog Devices, Inc., with a gain range of 24 dB. The gain control interface provides precise linear-in-dB scaling of 19.7 dB/V, referenced to VCOM.

FUNCTIONAL BLOCK DIAGRAM

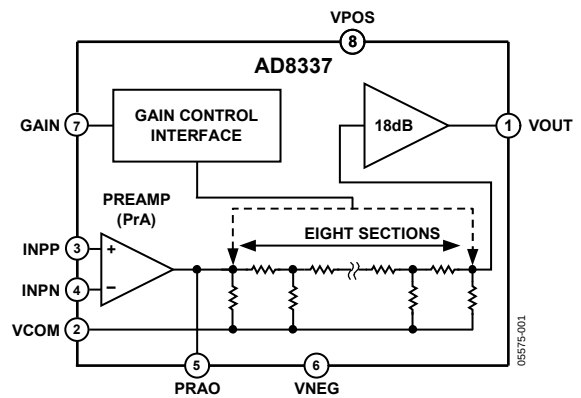


Figure 1.

The AD8337 includes an uncommitted operational current-feedback preamplifier (PrA) that operates in inverting or noninverting configurations. Using external resistors, the device can be configured for gains of 6 dB or greater. The AD8337 is characterized by a noninverting PrA gain of $2\times$ using two external $100\ \Omega$ resistors. The attenuator has a range of 24 dB, and the output amplifier has a fixed gain of $8\times$ (18.06 dB). The lowest nominal gain range is 0 dB to 24 dB and can be shifted up or down by adjusting the preamp gain. Multiple AD8337 devices can be connected in series for larger gain ranges, interstage filtering to suppress noise and distortion, and nulling offset voltages.

The operating temperature range of the AD8337 is -40°C to $+85^{\circ}\text{C}$, and is available in an 8-lead, $3\text{ mm} \times 3\text{ mm}$ LFCSP.

Rev. C

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REVISION HISTORY

9/08—Rev. B to Rev. C

Changes to Table 1	3
Added Exposed Pad Note to Figure 2 and Table 3	6
Changes to Figure 49	14
Changes to Evaluation Boards Section	23
Changes to Circuit Options Section	24
Changes to Output Protection Section	24
Changes to Measurement Setup Section	25
Changes to Board Layout Considerations Section	25
Changes to Bill of Materials Section	27
Updated Outline Dimensions, Changes to Ordering Guide	29

2/07—Rev. A to Rev. B

Changes to Figure 30, Figure 31, and Figure 32	11
Changes to Single-Supply Operation and AC Coupling Section	19
Moved Noise Section to Page	19
Changes to Ordering Guide	24

6/06—Rev. 0 to Rev. A

Updated Format	Universal
Changes to Table 3	6
Changes to Figure 22, Figure 25, and Figure 26	10
Changes to Figure 39 and Figure 40	13
Changes to Figure 74 and Figure 75	23
Updated Outline Dimensions	25
Changes to Ordering Guide	25

9/05—Revision 0: Initial Version

SPECIFICATIONS

$V_S = \pm 2.5\text{ V}$, $T_A = 25^\circ\text{C}$, PrA gain = +2, $V_{\text{COM}} = \text{GND}$, $f = 10\text{ MHz}$, $C_L = 5\text{ pF}$, $R_L = 500\ \Omega$, including a $20\ \Omega$ snubbing resistor, unless otherwise specified.

Table 1.

Parameter	Conditions	Min	Typ	Max	Unit
GENERAL PARAMETERS					
–3 dB Small Signal Bandwidth	$V_{\text{OUT}} = 10\text{ mV p-p}$		280		MHz
–3 dB Large Signal Bandwidth	$V_{\text{OUT}} = 1\text{ V p-p}$		100		MHz
Slew Rate	$V_{\text{OUT}} = 2\text{ V p-p}$		625		V/ μs
	$V_{\text{OUT}} = 1\text{ V p-p}$		490		V/ μs
Input Voltage Noise	$f = 10\text{ MHz}$		2.15		nV/ $\sqrt{\text{Hz}}$
Input Current Noise	$f = 10\text{ MHz}$		4.8		pA/ $\sqrt{\text{Hz}}$
Noise Figure	$V_{\text{GAIN}} = 0.7\text{ V}$, $R_S = 50\ \Omega$, unterminated		8.5		dB
	$V_{\text{GAIN}} = 0.7\text{ V}$, $R_S = 50\ \Omega$, shunt terminated with $50\ \Omega$		14		dB
Output-Referred Noise	$V_{\text{GAIN}} = 0.7\text{ V}$ (gain = 24 dB)		34		nV/ $\sqrt{\text{Hz}}$
	$V_{\text{GAIN}} = -0.7\text{ V}$ (gain = 0 dB)		21		nV/ $\sqrt{\text{Hz}}$
Output Impedance	DC to 10 MHz		1		Ω
Output Signal Range	$R_L \geq 500\ \Omega$, $V_S = \pm 2.5\text{ V}$, +5 V		$V_{\text{COM}} \pm 1.3$		V
	$R_L \geq 500\ \Omega$, $V_S = \pm 5\text{ V}$		$V_{\text{COM}} \pm 2.4$		V
Output Offset Voltage	$V_{\text{GAIN}} = 0.7\text{ V}$ (gain = 24 dB)	–25	± 5	+25	mV
DYNAMIC PERFORMANCE					
Harmonic Distortion	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$				
HD2	$f = 1\text{ MHz}$		–72		dBc
HD3			–66		dBc
HD2	$f = 10\text{ MHz}$		–62		dBc
HD3			–63		dBc
HD2	$f = 45\text{ MHz}$		–58		dBc
HD3			–56		dBc
Input 1 dB Compression Point	$V_{\text{GAIN}} = -0.7\text{ V}$, $f = 10\text{ MHz}$ (preamp limited)		8.2		dBm
	$V_{\text{GAIN}} = +0.7\text{ V}$, $f = 10\text{ MHz}$ (VGA limited)		–9.4		dBm
Two-Tone Intermodulation Distortion (IMD3)	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f_1 = 10\text{ MHz}$, $f_2 = 11\text{ MHz}$		–71		dBc
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f_1 = 45\text{ MHz}$, $f_2 = 46\text{ MHz}$		–57		dBc
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f_1 = 10\text{ MHz}$, $f_2 = 11\text{ MHz}$		–58		dBc
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f_1 = 45\text{ MHz}$, $f_2 = 46\text{ MHz}$		–45		dBc
Output Third-Order Intercept	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f = 10\text{ MHz}$		34		dBm
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f = 45\text{ MHz}$		28		dBm
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f = 10\text{ MHz}$		35		dBm
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f = 45\text{ MHz}$		26		dBm
Overload Recovery	$V_{\text{GAIN}} = 0.75\text{ V}$, $V_{\text{IN}} = 50\text{ mV p-p}$ to 500 mV p-p		50		ns
Group Delay Variation	$1\text{ MHz} < f < 100\text{ MHz}$, full gain range		± 1		ns

AD8337

Parameter	Conditions	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE	$V_S = \pm 5\text{ V}$				
Harmonic Distortion	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$				
HD2	$f = 1\text{ MHz}$		–85		dBc
HD3			–75		dBc
HD2	$f = 10\text{ MHz}$		–90		dBc
HD3			–80		dBc
HD2	$f = 35\text{ MHz}$		–75		dBc
HD3			–76		dBc
Input 1 dB Compression Point	$V_{\text{GAIN}} = -0.7\text{ V}$, $f = 10\text{ MHz}$		14.5		dBm
	$V_{\text{GAIN}} = +0.7\text{ V}$, $f = 10\text{ MHz}$		–1.7		dBm
Two-Tone Intermodulation Distortion (IMD3)	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f_1 = 10\text{ MHz}$, $f_2 = 11\text{ MHz}$		–74		dBc
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f_1 = 45\text{ MHz}$, $f_2 = 46\text{ MHz}$		–60		dBc
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f_1 = 10\text{ MHz}$, $f_2 = 11\text{ MHz}$		–64		dBc
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f_1 = 45\text{ MHz}$, $f_2 = 46\text{ MHz}$		–49		dBc
Output Third-Order Intercept	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f = 10\text{ MHz}$		35		dBm
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 1\text{ V p-p}$, $f = 45\text{ MHz}$		28		dBm
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f = 10\text{ MHz}$		36		dBm
	$V_{\text{GAIN}} = 0\text{ V}$, $V_{\text{OUT}} = 2\text{ V p-p}$, $f = 45\text{ MHz}$		28		dBm
Overload Recovery	$V_{\text{GAIN}} = 0.7\text{ V}$, $V_{\text{IN}} = 0.1\text{ V p-p}$ to 1 V p-p		50		ns
ACCURACY					
Absolute Gain Error	$-0.7\text{ V} < V_{\text{GAIN}} < -0.6\text{ V}$		0.7 to 3.5		dB
	$-0.6\text{ V} < V_{\text{GAIN}} < -0.5\text{ V}$	–1.25	± 0.35	+1.25	dB
	$-0.5\text{ V} < V_{\text{GAIN}} < +0.5\text{ V}$	–1.0	± 0.25	+1.0	dB
	$0.5\text{ V} < V_{\text{GAIN}} < 0.6\text{ V}$	–1.25	± 0.35	+1.25	dB
	$0.6\text{ V} < V_{\text{GAIN}} < 0.7\text{ V}$		–0.7 to –3.5		dB
GAIN CONTROL INTERFACE					
Gain Scaling Factor	$-0.6\text{ V} < V_{\text{GAIN}} < +0.6\text{ V}$		19.7		dB/V
Gain Range			24		dB
Intercept	$V_{\text{GAIN}} = 0\text{ V}$		12.65		dB
Input Voltage (V_{GAIN}) Range	No foldover	$-V_S$		$+V_S$	V
Input Impedance			70		M Ω
Bias Current	$-0.7\text{ V} < V_{\text{GAIN}} < +0.7\text{ V}$		0.3		μA
Response Time	24 dB gain change		200		ns
POWER SUPPLY					
Supply Voltage	V_{POS} to V_{NEG} (dual- or single-supply operation)	4.5	5	10	V
$V_S = \pm 2.5\text{ V}$					
Quiescent Current	Each supply (V_{POS} and V_{NEG})	10.5	15.5	23.5	mA
Power Dissipation	No signal, V_{POS} to $V_{\text{NEG}} = 5\text{ V}$		78		mW
PSRR	$V_{\text{GAIN}} = 0.7\text{ V}$, $f = 1\text{ MHz}$		–40		dB
$V_S = \pm 5\text{ V}$					
Quiescent Current	Each supply (V_{POS} and V_{NEG})	13.5	18.5	25.5	mA
Power Dissipation	No signal, V_{POS} to $V_{\text{NEG}} = 10\text{ V}$		185		mW
PSRR	$V_{\text{GAIN}} = 0.7\text{ V}$, $f = 1\text{ MHz}$		–40		dB

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Voltage	
Supply Voltage (VPOS, VNEG)	$\pm 6\text{ V}$
Input Voltage (INPx)	VPOS, VNEG
GAIN Voltage	VPOS, VNEG
Power Dissipation (Exposed Pad Soldered to PCB)	866 mW
Temperature	
Operating Temperature Range	-40°C to $+85^{\circ}\text{C}$
Storage Temperature Range	-65°C to $+150^{\circ}\text{C}$
Lead Temperature (Soldering, 60 sec)	300°C
Thermal Data, 4-Layer JEDEC Board No Air Flow Exposed Pad Soldered to PCB	
θ_{JA}	75.4°C/W
θ_{JB}	47.5°C/W
θ_{JC}	17.9°C/W
ψ_{JT}	2.2°C/W
ψ_{JB}	46.2°C/W

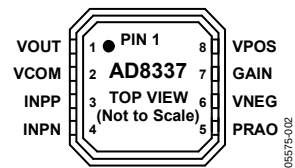
Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES
1. FOR BEST THERMAL PERFORMANCE, EXPOSED PAD
MUST BE SOLDERED TO PCB.

Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	VOUT	VGA Output.
2	VCOM	Common Ground When Using Plus and Minus Supply Voltages. For single-supply operation, provide half the positive supply voltage at the VPOS pin to VCOM pin.
3	INPP	Positive Input to Preamplifier.
4	INPN	Negative Input to Preamplifier.
5	PRAO	Preamplifier Output.
6	VNEG	Negative Supply (–VPOS for Dual-Supply; GND for Single-Supply).
7	GAIN	Gain Control Input Centered at VCOM.
8	VPOS	Positive Supply.
EP	Exposed Pad	For best thermal performance, exposed pad must be soldered to PCB.

TYPICAL PERFORMANCE CHARACTERISTICS

$V_S = \pm 2.5$ V, $T_A = 25^\circ\text{C}$, $R_L = 500\ \Omega$, including a $20\ \Omega$ snubbing resistor, $f = 10$ MHz, $C_L = 2$ pF, $V_{IN} = 10$ mV p-p, noninverting configuration, unless otherwise noted.

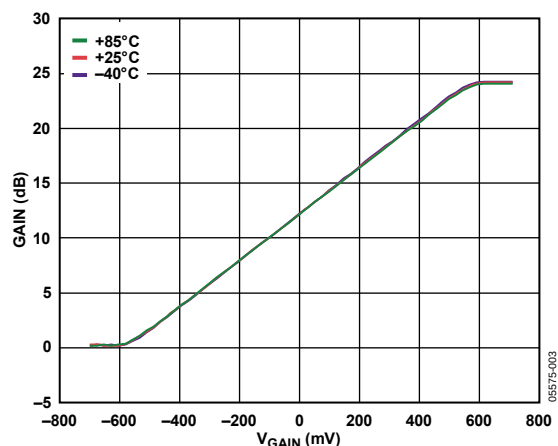


Figure 3. Gain vs. V_{GAIN} at Three Temperatures
(See Figure 44)

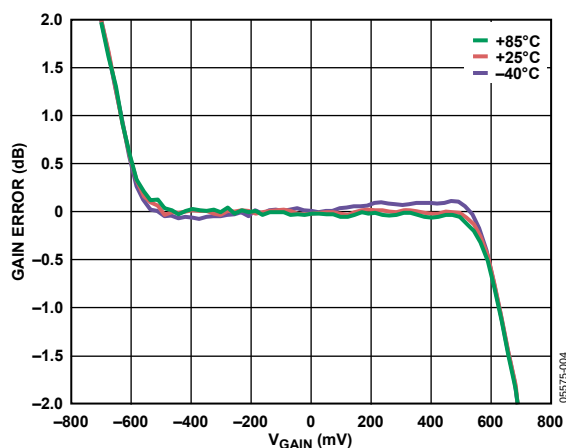


Figure 4. Gain Error vs. V_{GAIN} at Three Temperatures
(See Figure 44)

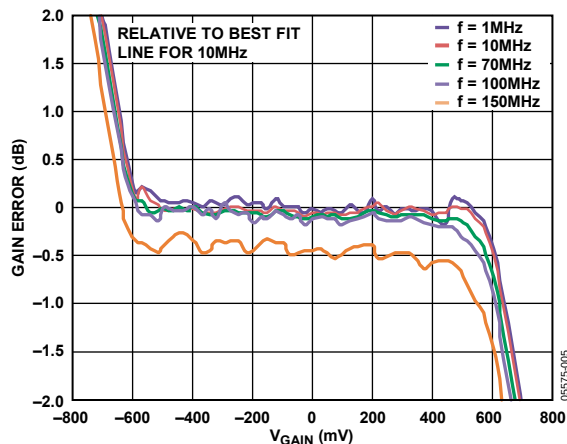


Figure 5. Gain Error vs. V_{GAIN} at Five Frequencies
(See Figure 44)

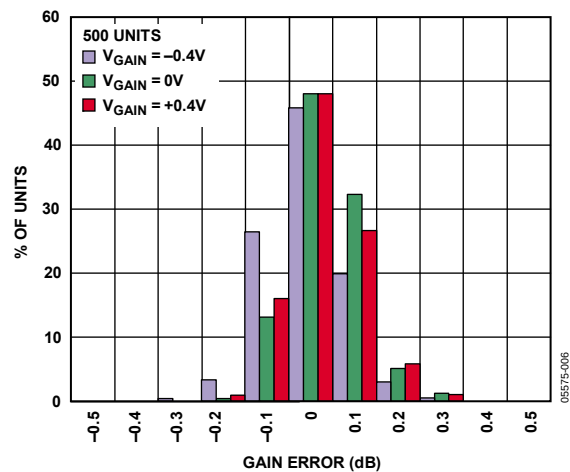


Figure 6. Gain Error Histogram for Three Values of V_{GAIN}

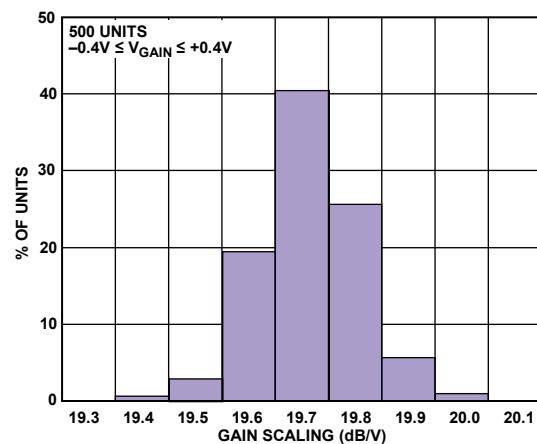


Figure 7. Gain Scaling Histogram

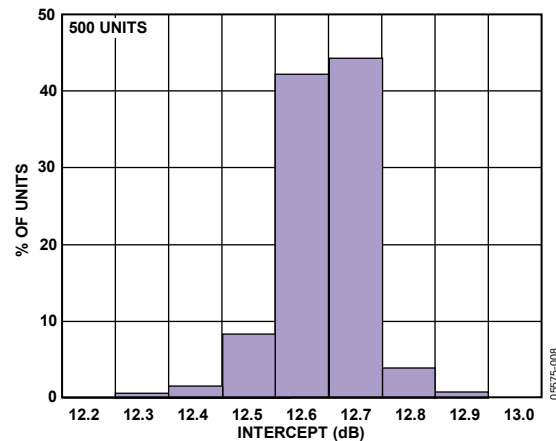


Figure 8. Intercept Histogram

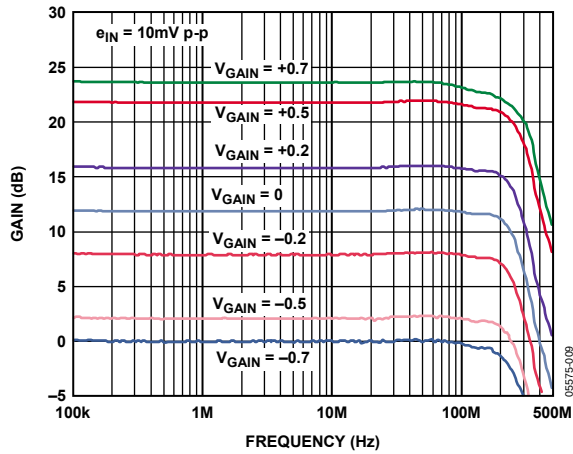


Figure 9. Frequency Response for Various Values of V_{GAIN}
(See Figure 45)

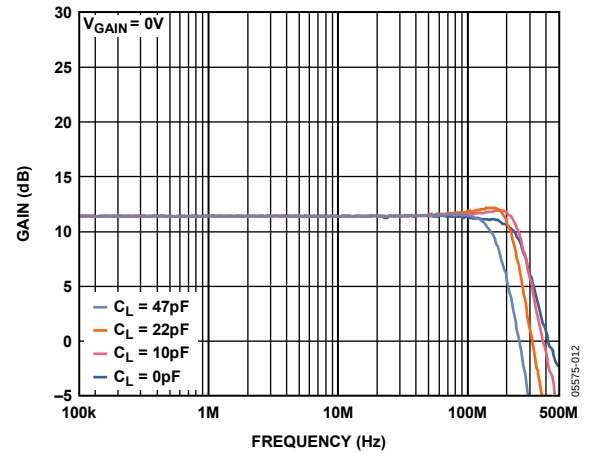


Figure 12. Frequency Response for Three Values of C_L
with a $20\ \Omega$ Snubbing Resistor (See Figure 45)

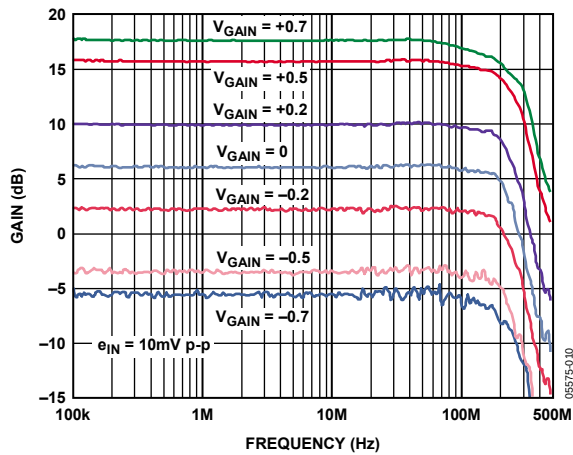


Figure 10. Frequency Response for Various Values of V_{GAIN} —Inverting Input
(See Figure 58)

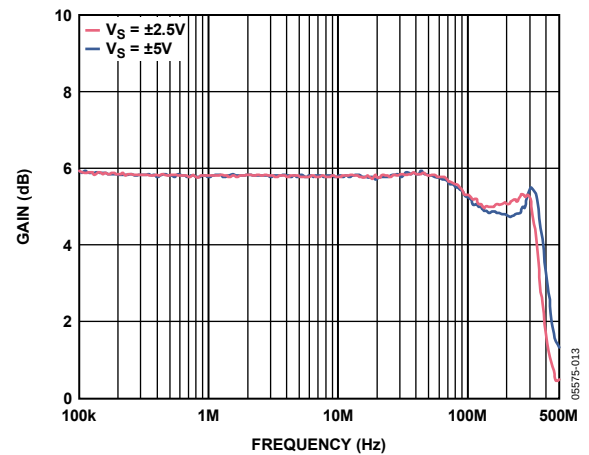


Figure 13. Frequency Response—Preamp
(See Figure 46)

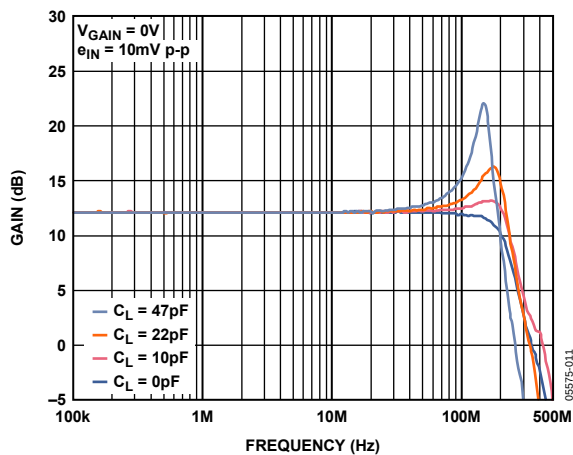


Figure 11. Frequency Response for Three Values of C_L
(See Figure 45)

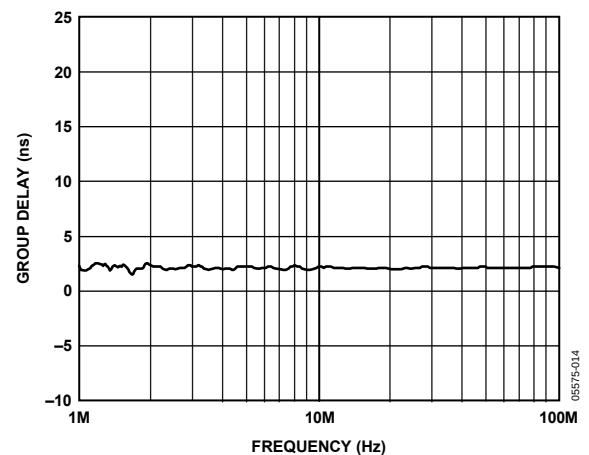


Figure 14. Group Delay vs. Frequency
(See Figure 47)

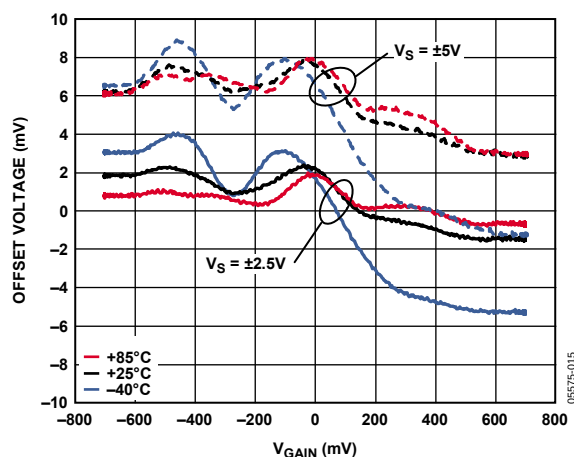


Figure 15. Offset Voltage vs. V_{GAIN} at Three Temperatures
(See Figure 48)

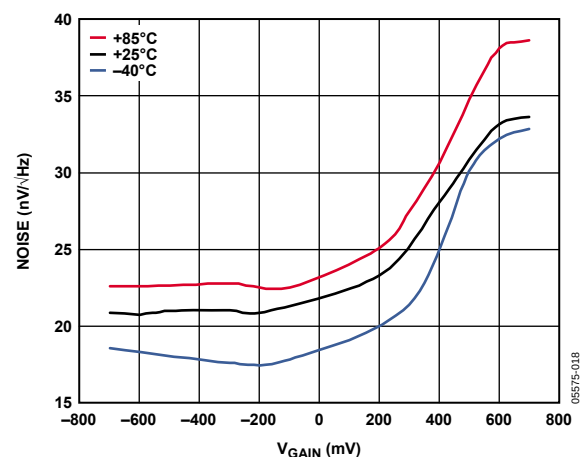


Figure 18. Output-Referred Noise vs. V_{GAIN} at Three Temperatures
(See Figure 50)

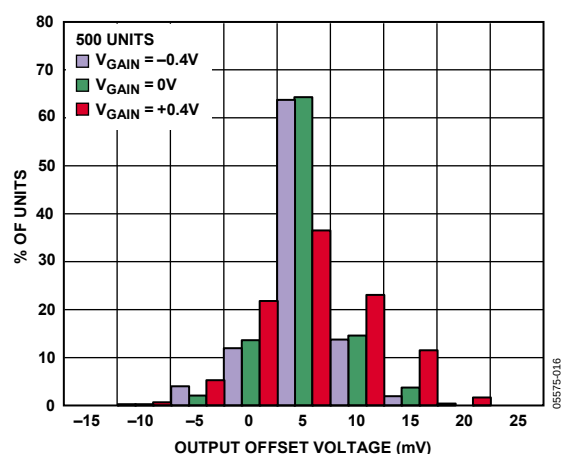


Figure 16. Output Offset Voltage Histogram for Three Values of V_{GAIN}

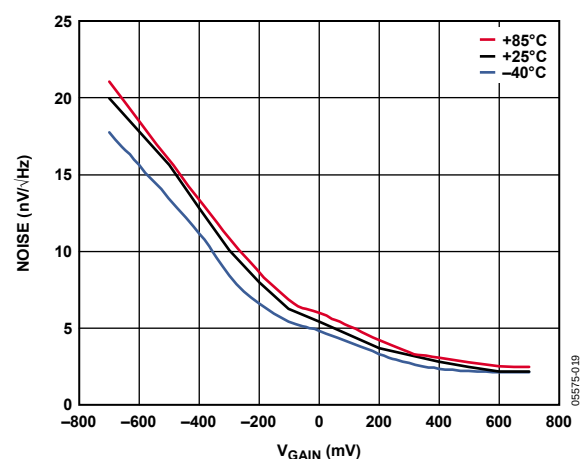


Figure 19. Short-Circuit, Input-Referred Noise at Three Temperatures
(See Figure 50)

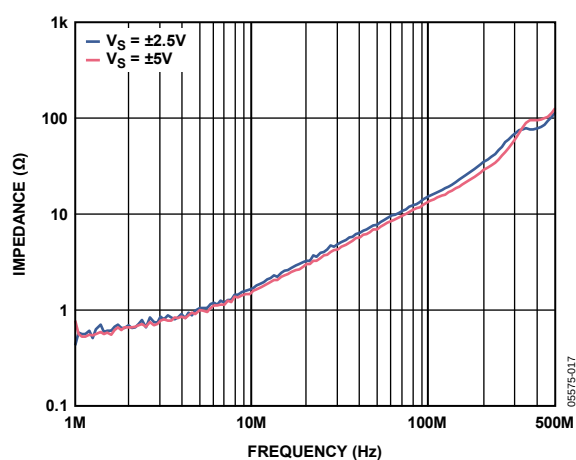


Figure 17. VGA Output Impedance vs. Frequency
(See Figure 49)

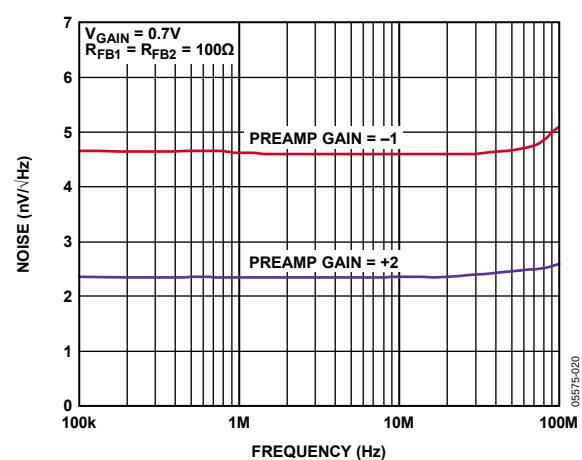


Figure 20. Short-Circuit, Input-Referred Noise vs. Frequency at Maximum Gain—Inverting and Noninverting Preamp Gain = -1 and +2
(See Figure 50)

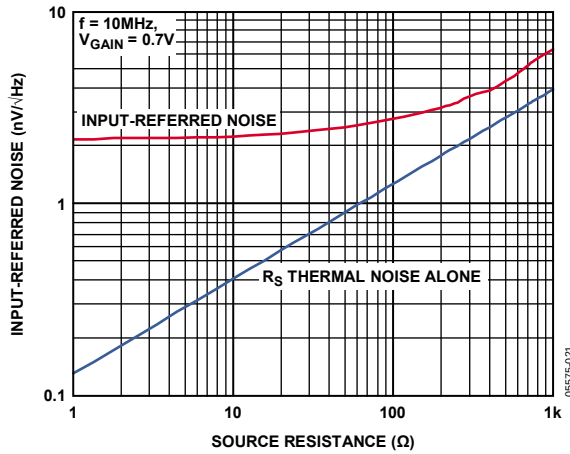


Figure 21. Input-Referred Noise vs. R_s
(See Figure 61)

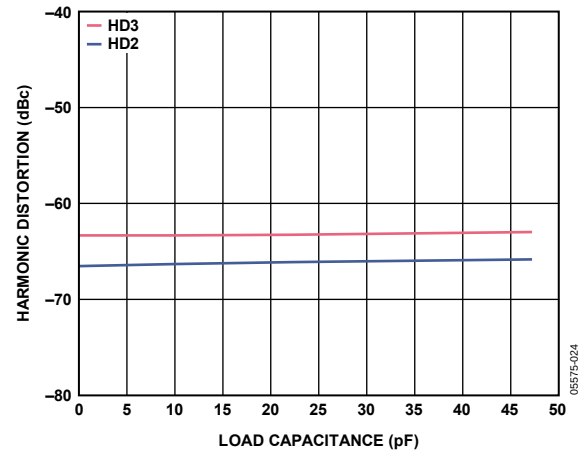


Figure 24. Harmonic Distortion vs. Load Capacitance
(See Figure 52)

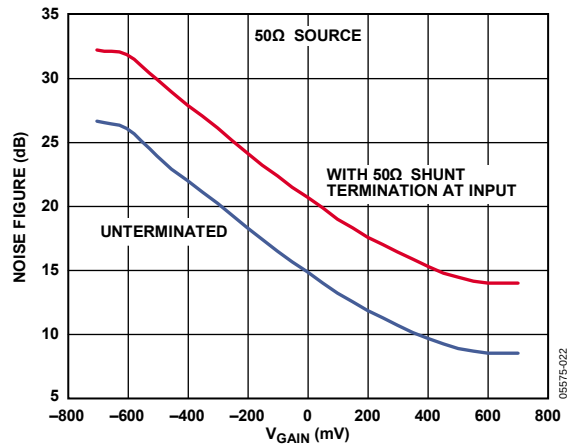


Figure 22. Noise Figure vs. V_{GAIN}
(See Figure 51)

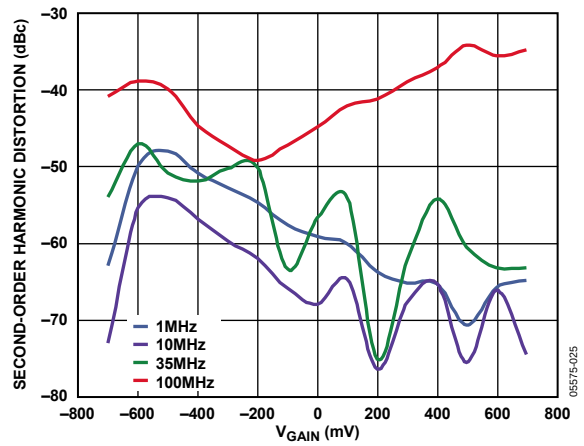


Figure 25. HD2 vs. V_{GAIN} at Four Frequencies
(See Figure 52)

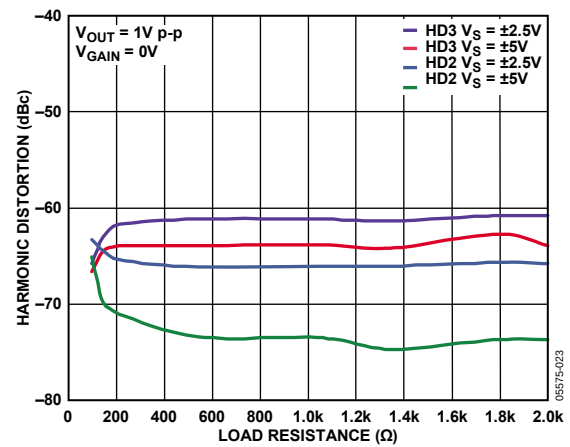


Figure 23. Harmonic Distortion vs. R_L and Supply Voltage
(See Figure 52)

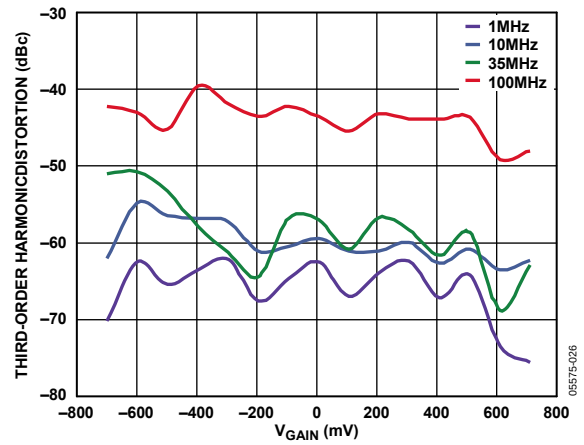


Figure 26. HD3 vs. V_{GAIN} at Four Frequencies
(See Figure 52)

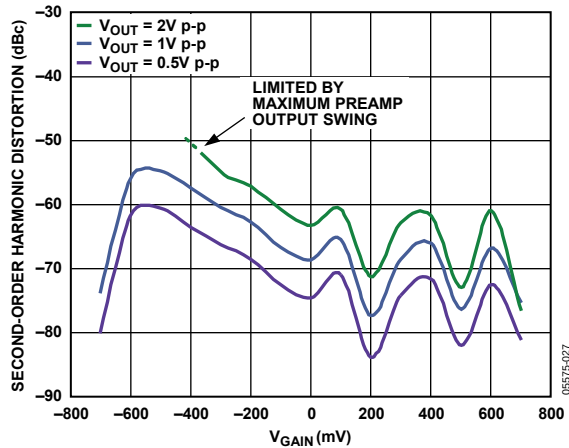


Figure 27. HD2 vs. V_{GAIN} for Three Levels of Output Voltage
(See Figure 52)

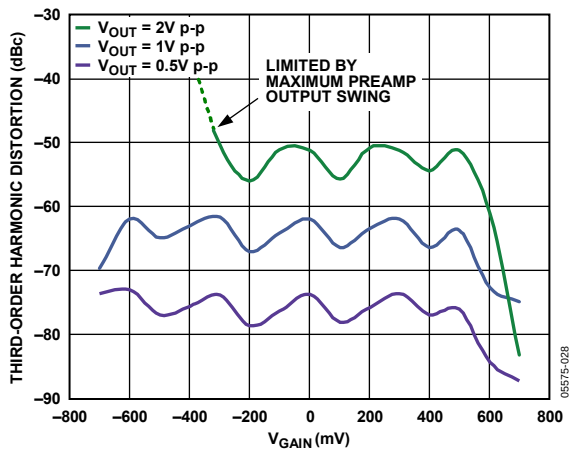


Figure 28. HD3 vs. V_{GAIN} for Three Levels of Output Voltage
(See Figure 52)

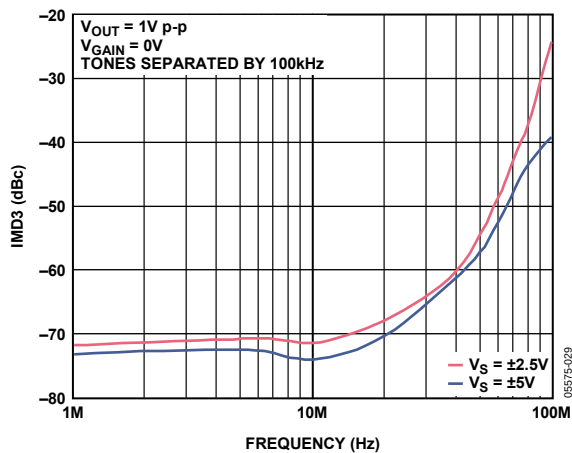


Figure 29. IMD3 vs. Frequency
(See Figure 64)

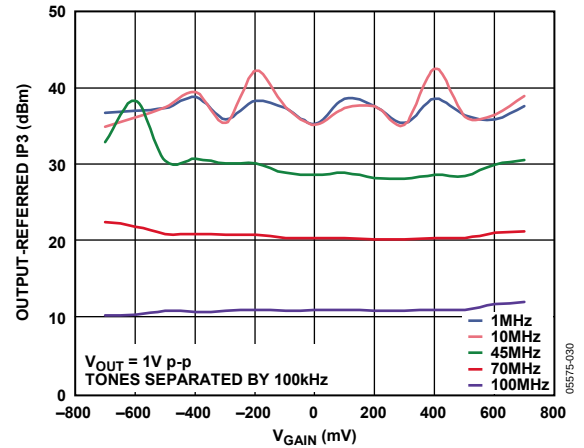


Figure 30. Output-Referred IP3 (OIP3) vs. V_{GAIN}
at Five Frequencies (See Figure 64)

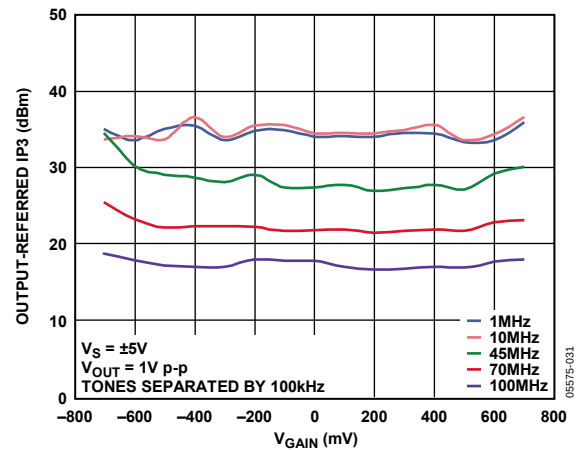


Figure 31. Output-Referred IP3 (OIP3) vs. V_{GAIN} , $V_S = \pm 5V$
at Five Frequencies (See Figure 64)

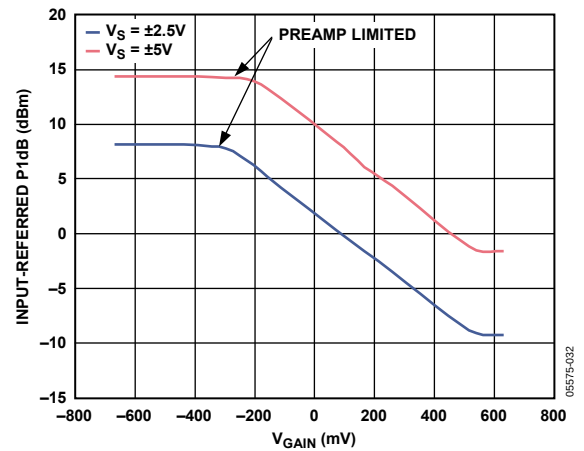


Figure 32. Input-Referred P1dB (IP1dB) vs. V_{GAIN}
(See Figure 63)

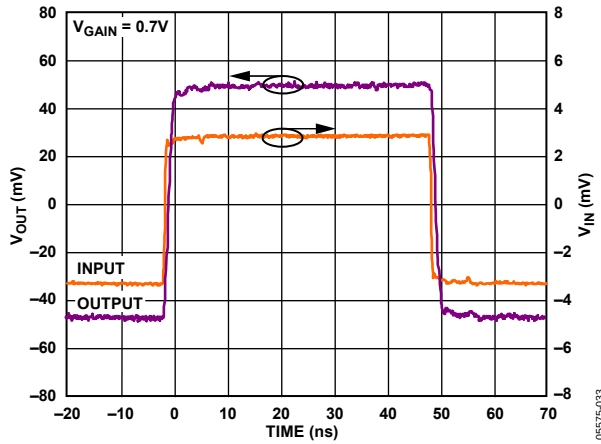


Figure 33. Small Signal Pulse Response
(See Figure 53)

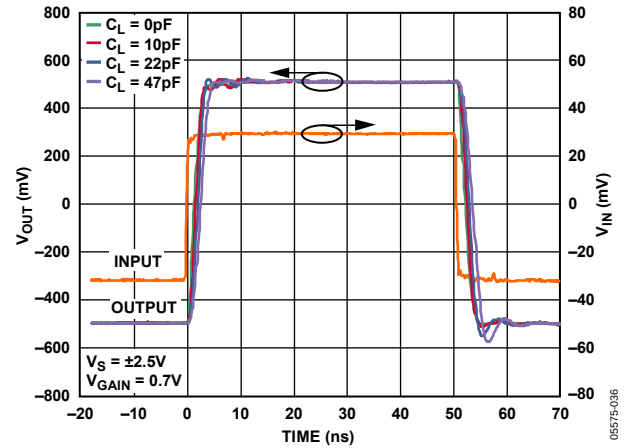


Figure 36. Large Signal Pulse Response for Three Capacitive Loads
(See Figure 53)

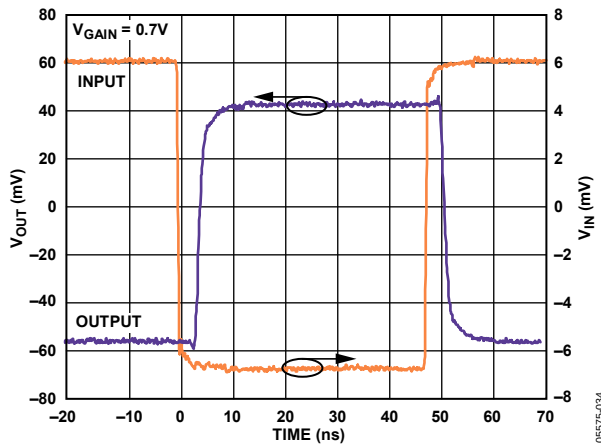


Figure 34. Small Signal Pulse Response—Inverting Feedback
(See Figure 59)

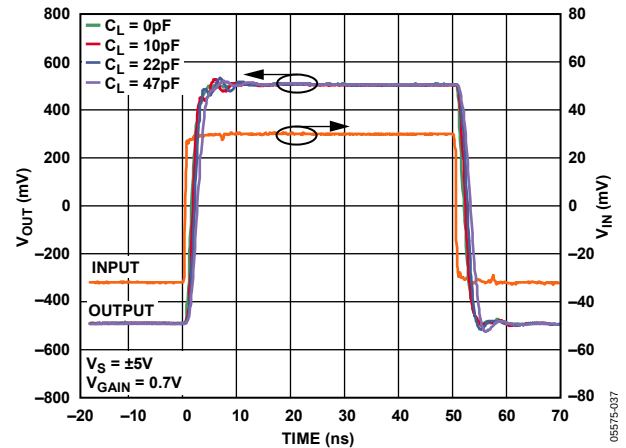


Figure 37. Large Signal Pulse Response for Three Capacitive Loads, $V_S = \pm 5V$
(See Figure 53)

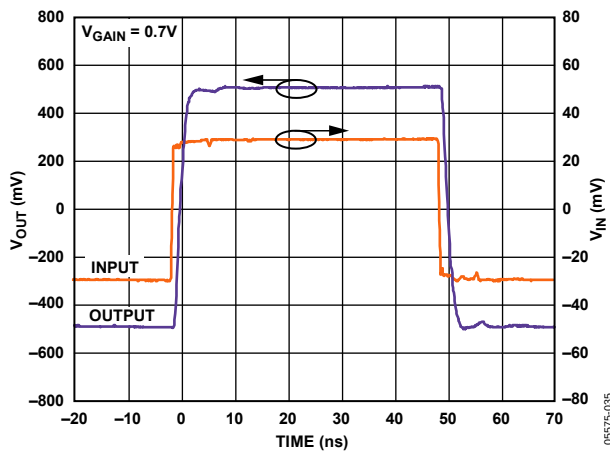


Figure 35. Large Signal Pulse Response
(See Figure 53)

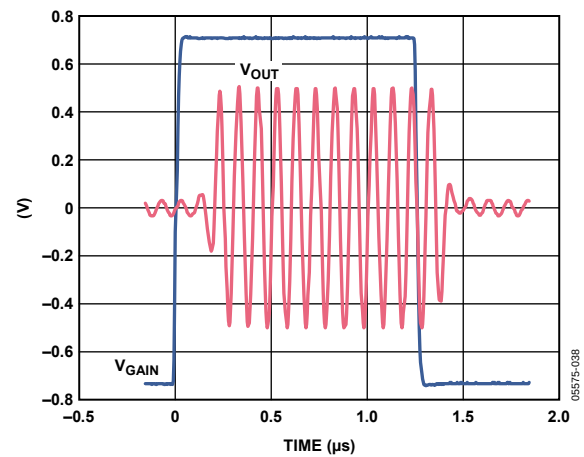


Figure 38. Gain Response
(See Figure 54)

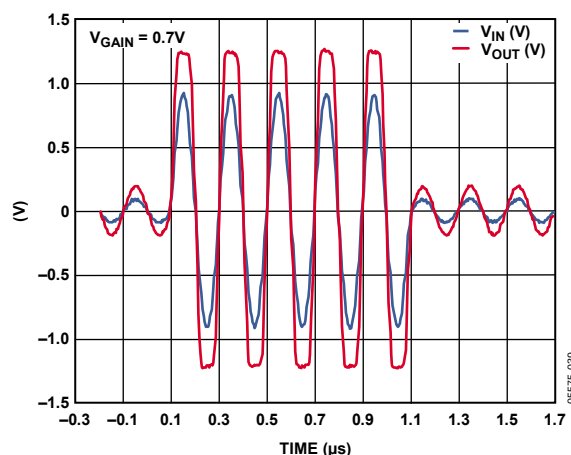


Figure 39. Preamplifier Overdrive Recovery
(See Figure 55)

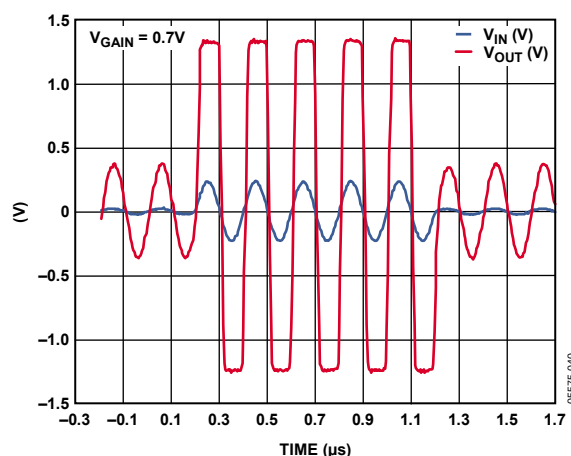


Figure 40. VGA Overdrive Recovery
(See Figure 56)

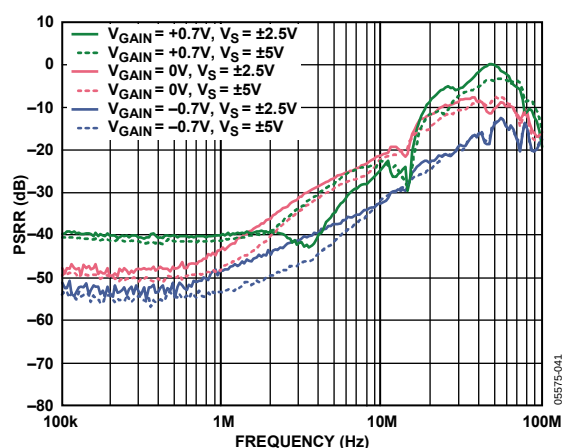


Figure 41. PSRR vs. Frequency of Positive Supply
(See Figure 60)

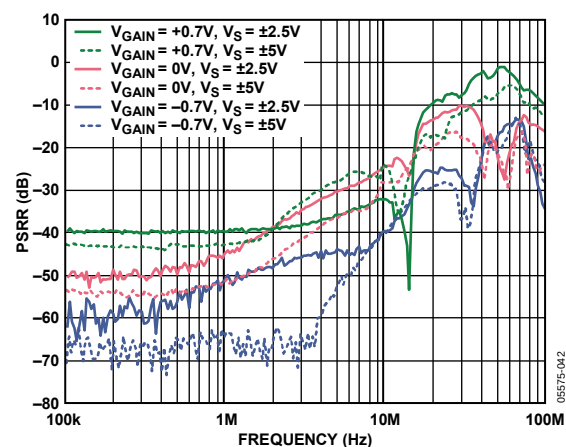


Figure 42. PSRR vs. Frequency of Negative Supply
(See Figure 60)

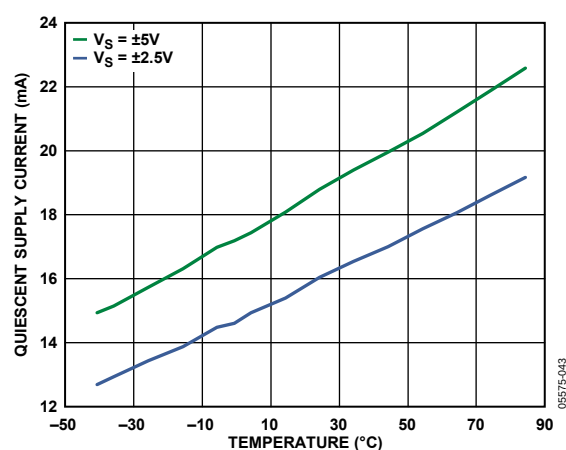


Figure 43. Quiescent Supply Current vs. Temperature
(See Figure 57)

TEST CIRCUITS

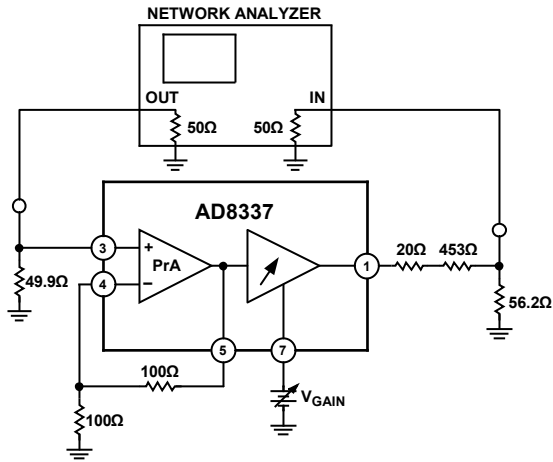


Figure 44. Gain and Gain Error vs. V_{GAIN}

05575-044

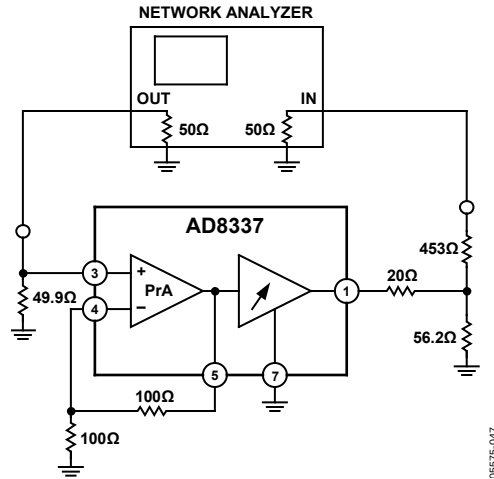


Figure 47. Group Delay

05575-047

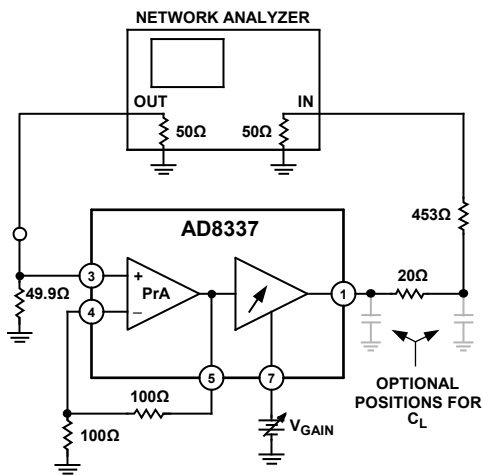


Figure 45. Frequency Response

05575-045

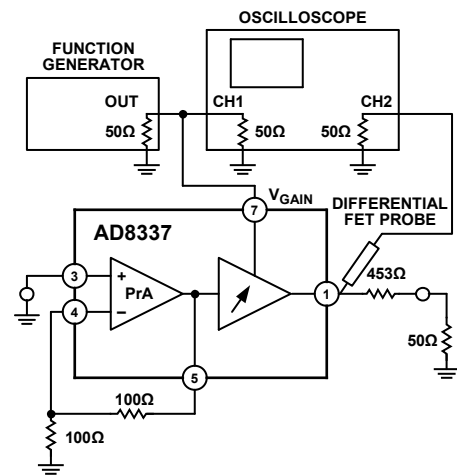


Figure 48. Offset Voltage

05575-048

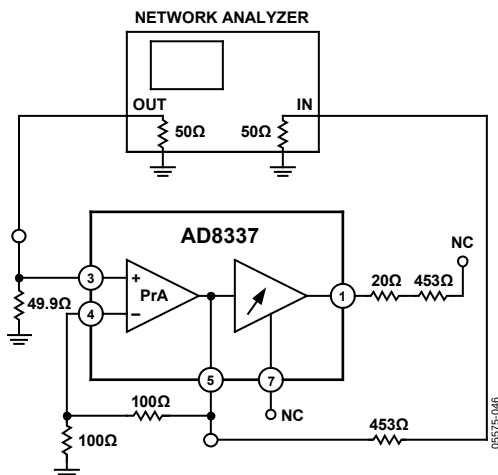


Figure 46. Frequency Response—Preamp

05575-046

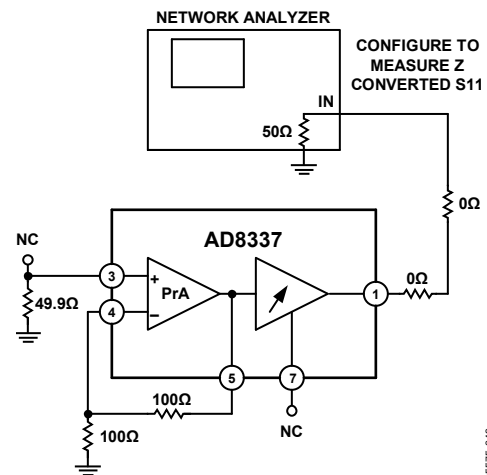


Figure 49. Output Impedance vs. Frequency

05575-049

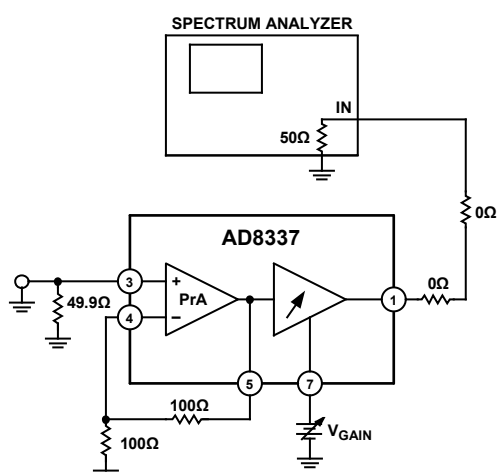


Figure 50. Input-Referred and Output-Referred Noise

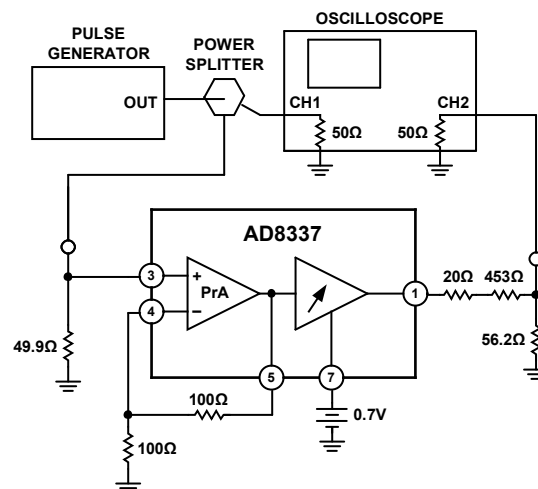


Figure 53. Pulse Response

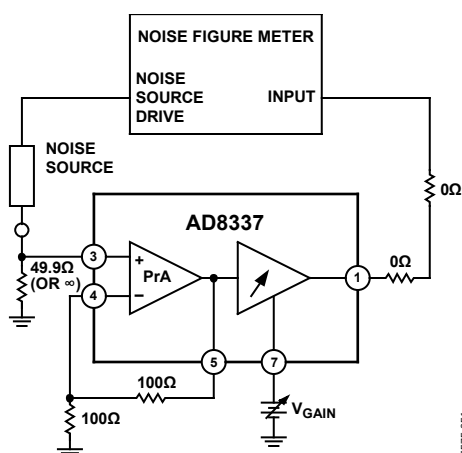


Figure 51. Noise Figure vs. V_{GAIN}

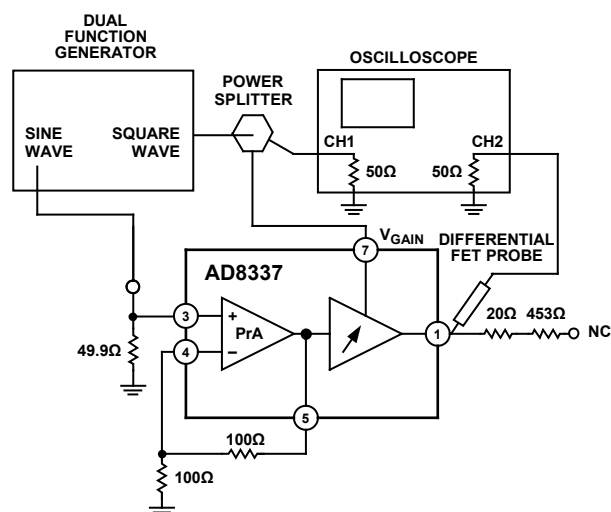


Figure 54. Gain Response

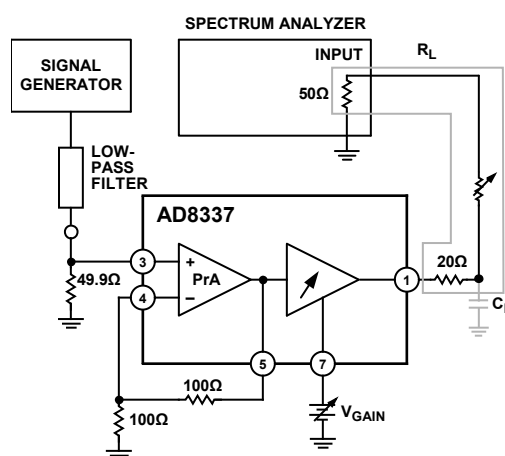


Figure 52. Harmonic Distortion

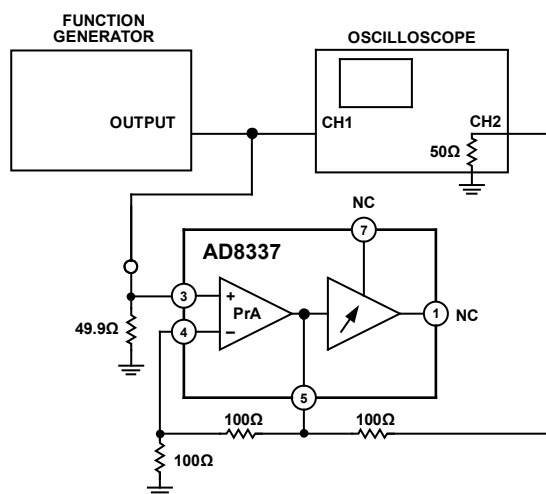


Figure 55. Preamp Overdrive Recovery

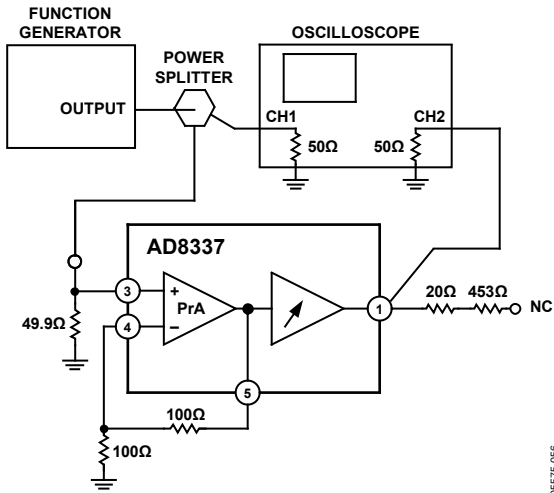


Figure 56. VGA Overdrive Recovery

05575-056

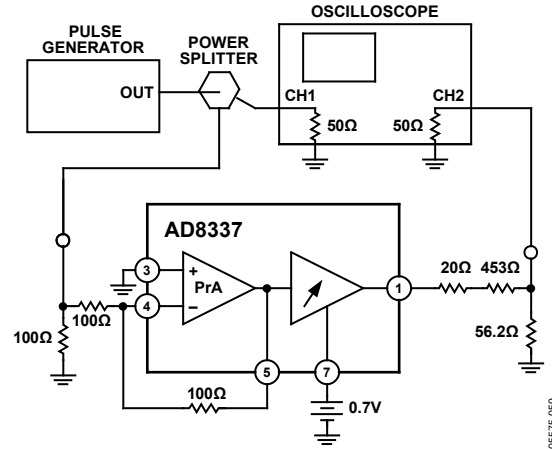


Figure 59. Pulse Response—Inverting Feedback

05575-059

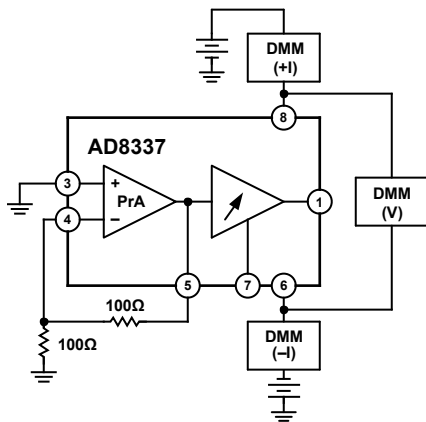


Figure 57. Supply Current

05575-057

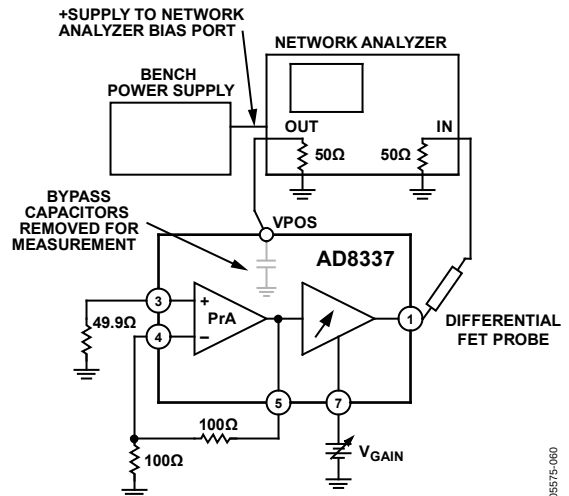


Figure 60. PSRR

05575-060

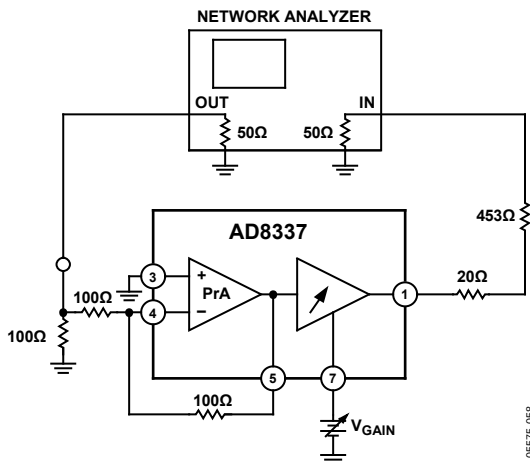


Figure 58. Frequency Response—Inverting Feedback

05575-058

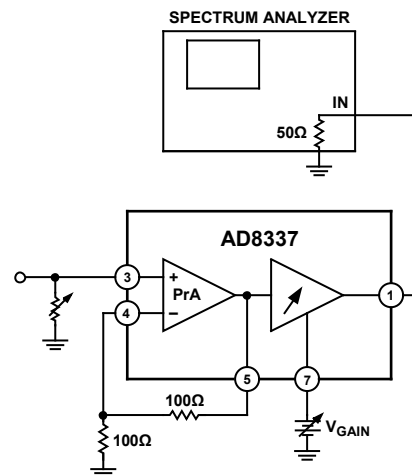


Figure 61. Input-Referred Noise vs. R_s

05575-061

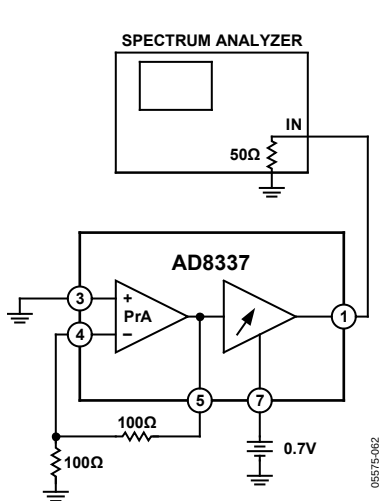


Figure 62. Short-Circuit Input Noise vs. Frequency

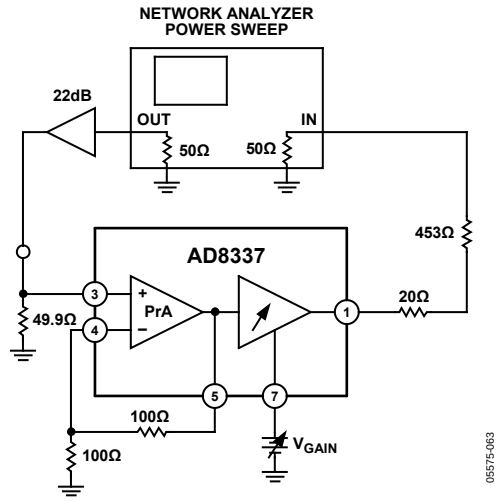


Figure 63. IP1dB vs. V_{GAIN}

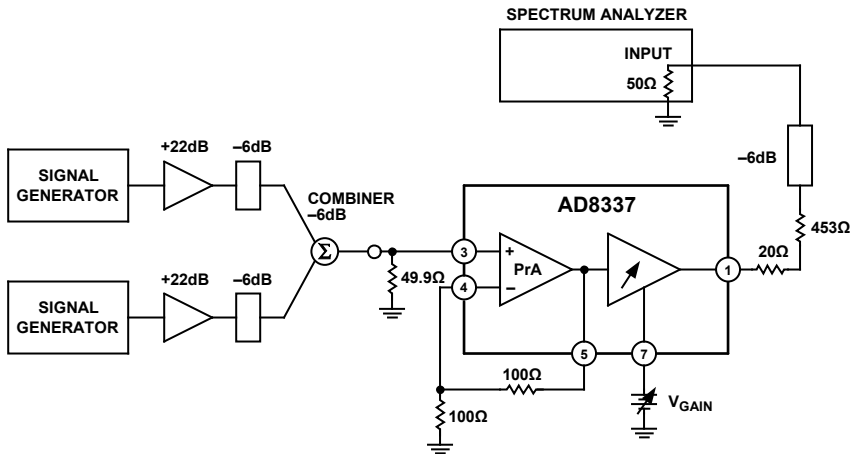


Figure 64. IMD and OIP3

The gain scaling factor (gain slope) is designed for 20 dB/V. This relatively low slope ensures that noise on the GAIN input is not unduly amplified. Because a VGA functions as a multiplier, it is important that the GAIN input does not inadvertently modulate the output signal with unwanted noise. Because of its high input impedance, a simple low-pass filter can be added to the GAIN input to filter unwanted noise.

OUTPUT STAGE

The output stage is a Class AB, voltage-feedback, complementary emitter-follower with a fixed gain of 18 dB, similar to the preamplifier in speed and bandwidth. Because of the ac-beta roll-off of the output devices and the inherent reduction in feedback beyond the -3 dB bandwidth, the impedance looking into the output pin of the preamp and output stages appears to be inductive (increasing impedance with increasing frequency). The high speed output amplifier used in the AD8337 can drive large currents, but its stability is susceptible to capacitive loading. A small series resistor mitigates the effects of capacitive loading (see the Applications Information section).

ATTENUATOR

The input resistance of the VGA attenuator is nominally 265 Ω . For example, if the default preamplifier feedback network $R_{FB1} + R_{FB2}$ is 200 Ω , the effective preamplifier load is approximately 114 Ω . The attenuator is composed of eight 3.01 dB sections for a total attenuation range of -24.08 dB. Following the attenuator is a fixed gain amplifier with 8 $\times$ (18.06 dB) gain. Because of this relatively low gain, the output offset is kept well below 20 mV over temperature; the offset is largest at maximum gain when the preamplifier offset is amplified. The VCOM pin defines the common-mode reference for the output, as shown in Figure 65.

SINGLE-SUPPLY OPERATION AND AC COUPLING

If the AD8337 is to be operated from a single 5 V supply, the bias supply for VCOM must be a very low impedance 2.5 V reference, especially if dc coupling is used. If the device is dc-coupled, the VCOM source must be able to handle the preamplifier and VGA dynamic load currents in addition to the bias currents.

When ac coupling the preamplifier input, a bias network and bypass capacitor must be connected to the opposite polarity input pin. The bias generator for the VCOM pin must provide the dynamic current to the preamplifier feedback network and the VGA attenuator. For many single 5 V applications, a reference, such as the [ADR391](#), and a good op amp provide an adequate VCOM source if a 2.5 V supply is unavailable.

NOISE

The total input-referred voltage and current noise of the positive input of the preamplifier are about 2.2 nV/ $\sqrt{\text{Hz}}$ and 4.8 pA/ $\sqrt{\text{Hz}}$. The VGA output-referred noise is about 21 nV/ $\sqrt{\text{Hz}}$ at low gains. This result is divided by the VGA fixed gain amplifier gain of 8 $\times$ and results in a voltage noise density of 2.6 nV/ $\sqrt{\text{Hz}}$ referred to the VGA input. This value includes the noise of the VGA gain setting resistors as well. If this voltage is again divided by the preamp gain of 2, the VGA noise referred all the way to the preamp input is about 1.3 nV/ $\sqrt{\text{Hz}}$. From this, it is determined that the preamplifier, including the 100 Ω gain setting resistors, contributes about 1.8 nV/ $\sqrt{\text{Hz}}$. The two 100 Ω resistors contribute 1.29 nV/ $\sqrt{\text{Hz}}$ each at the output of the preamp. With the gain resistor noise subtracted, the preamplifier noise is approximately 1.55 nV/ $\sqrt{\text{Hz}}$.

Equation 2 shows the calculation that determines the output-referred noise at maximum gain (24 dB or 16 $\times$).

where:

A_t is the total gain from preamp input to VGA output.

R_S is the source resistance.

e_{n-PrA} is the input-referred voltage noise of the preamp.

i_{n-PrA} is the current noise of the preamp at the INPP pin.

$e_{n-R_{FB1}}$ is the voltage noise of R_{FB1} .

$e_{n-R_{FB2}}$ is the voltage noise of R_{FB2} .

e_{n-VGA} is the input-referred voltage noise of the VGA (low gain, output-referred noise divided by a fixed gain of 8 $\times$).

Assuming $R_S = 0 \Omega$, $R_{FB1} = R_{FB2} = 100 \Omega$, $A_t = 16\times$, and $A_{VGA} = 8\times$, the noise simplifies to

$$e_{n-out} = \sqrt{(1.75 \times 16)^2 + 2(1.29 \times 8)^2 + (1.9 \times 8)^2} = 35 \text{ nV}/\sqrt{\text{Hz}} \quad (1)$$

Dividing the result by 16 gives the total input-referred noise with a short-circuited input as 2.2 nV/ $\sqrt{\text{Hz}}$. When the preamplifier is used in the inverting configuration with the same R_{FB1} and $R_{FB2} = 100 \Omega$ as previously noted, e_{n-out} does not change. However, because the gain dropped by 6 dB, the input-referred noise increases by a factor of 2 to about 4.4 nV/ $\sqrt{\text{Hz}}$. The reason for this increase is that the noise gain to the output of the noise generators stays the same, yet the preamp in the inverting configuration has a gain of -1 compared to the +2 in the noninverting configuration; this increases the input-referred noise by 2.

$$e_{n-out} = \sqrt{(e_n R_S \times A_t)^2 + (e_{n-PrA} \times A_t)^2 + (i_{n-PrA} \times R_S)^2 + (e_{n-R_{FB1}} \times \frac{R_{FB2}}{R_{FB1}} \times A_{VGA})^2 + (e_{n-R_{FB2}} \times A_{VGA})^2 + (e_{n-VGA} \times A_{VGA})^2} \quad (2)$$

APPLICATIONS INFORMATION

PREAMPLIFIER CONNECTIONS

Noninverting Gain Configuration

The AD8337 preamplifier is an uncommitted current-feedback op amp that is stable for values of $R_{FB2} \geq 100 \Omega$. See Figure 66 for the noninverting feedback connections.

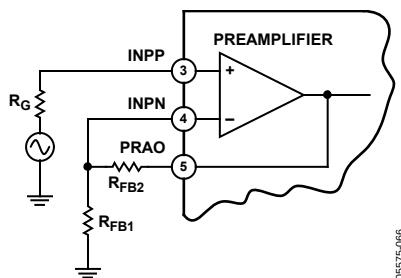


Figure 66. AD8337 Preamplifier Configured for Noninverting Gain

Two surface-mount resistors establish the preamplifier gain. Equal values of 100Ω configure the preamplifier for a 6 dB gain and the device for a default gain range of 0 dB to 24 dB.

For preamplifier gains ≥ 2 , select a value of $R_{FB2} \geq 100 \Omega$ and $R_{FB1} \leq 100 \Omega$. Higher values of R_{FB2} reduce the bandwidth and increase the offset voltage, but smaller values compromise stability. If $R_{FB1} \leq 100 \Omega$, the gain increases and the input-referred noise decreases.

Inverting Gain Configuration

For applications requiring polarity inversion of negative pulses, or for waveforms that require current sinking, the preamplifier can be configured as an inverting gain amplifier. When configured with bipolar supplies, the preamplifier amplifies positive or negative input voltages with no level shifting of the common-mode input voltage required. Figure 67 shows the AD8337 configured for inverting gain operation.

Because the AD8337 is a very high frequency device, stability issues can occur unless the circuit board on which it is used is carefully laid out. The stability of the preamp is affected by parasitic capacitance around the INPN pin. To minimize stray capacitance position the preamp gain resistors, R_{FB1} and R_{FB2} , as close as possible to the INPN pin.

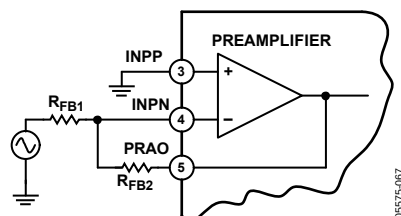


Figure 67. The AD8337 Preamplifier Configured for Inverting Gain

DRIVING CAPACITIVE LOADS

Because of the large bandwidth of the AD8337, stray capacitance at the output pin can induce peaking in the frequency response as the gain of the amplifier begins to roll off. Figure 68 shows peaking with two values of load capacitance using $\pm 2.5 \text{ V}$ supplies and $V_{\text{GAIN}} = 0 \text{ V}$.

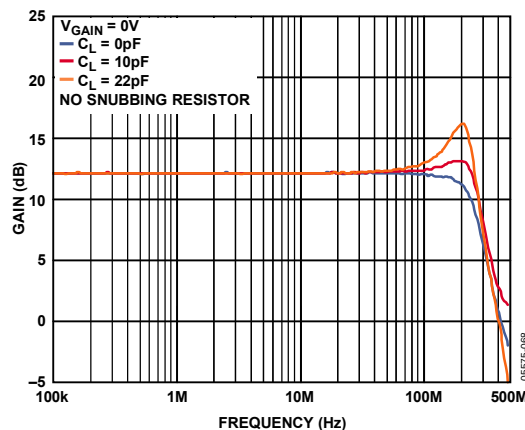


Figure 68. Peaking in the Frequency Response for Two Values of Output Capacitance with $\pm 2.5 \text{ V}$ Supplies and No Snubbing Resistor

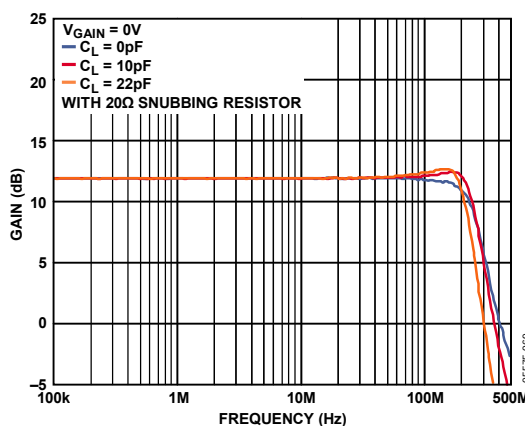


Figure 69. Frequency Response for Two Values of Output Capacitance with a 20Ω Snubbing Resistor

In the time domain, stray capacitance at the output pin can induce overshoot on the edges of transient signals, as shown in Figure 70 and Figure 72. The amplitude of the overshoot is also a function of the slewing of the transient (not shown in Figure 70 and Figure 72). The transition time of the input pulses used for Figure 70 and Figure 72 is deliberately set high at 300 ps to demonstrate the fast response time of the amplifier. Signals with longer transition times generate less overshoot.

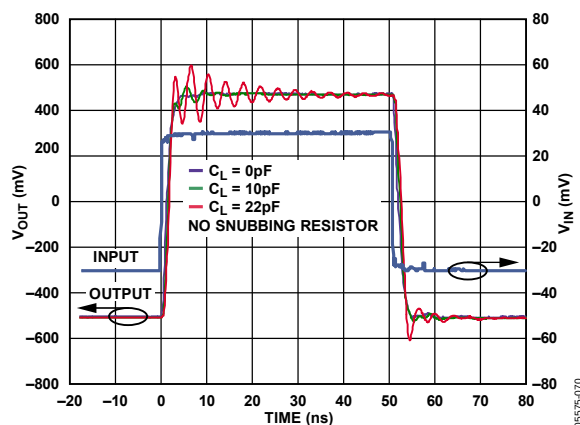


Figure 70. Pulse Response for Two Values of Output Capacitance with ± 2.5 V Supplies and No Snubbing Resistor

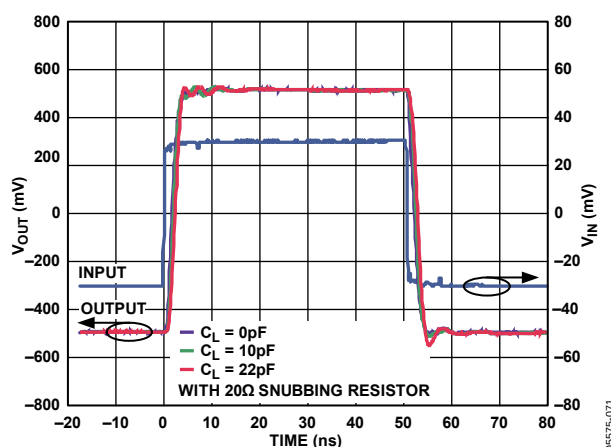


Figure 71. Pulse Response for Two Values of Output Capacitance with ± 2.5 V Supplies and a $20\ \Omega$ Snubbing Resistor

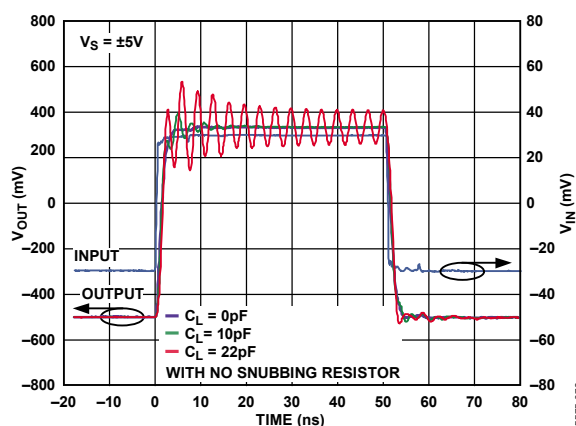


Figure 72. Large Signal Pulse Response for Two Values of Output Capacitance with ± 5 V Supplies and No Snubbing Resistor

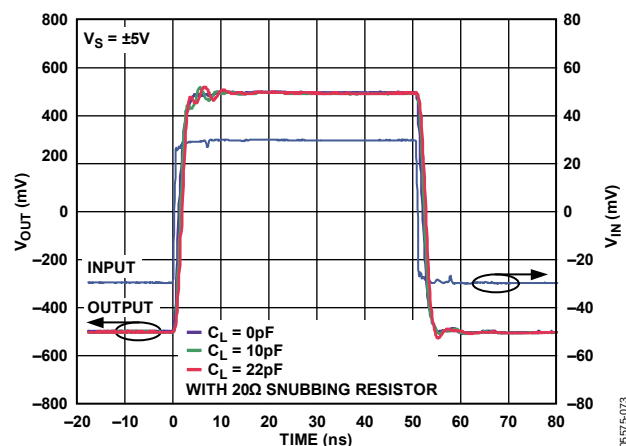


Figure 73. Pulse Response for Two Values of Output Capacitance with ± 5 V Supplies and a $20\ \Omega$ Snubbing Resistor

The effects of stray output capacitance are mitigated with a small value snubbing resistor, R_{SNUB} , placed in series with, and as near as possible to, the V_{OUT} pin. Figure 69, Figure 71, and Figure 73 show the improvement in dynamic performance with a $20\ \Omega$ snubbing resistor. R_{SNUB} reduces the gain slightly by the ratio of $R_L/(R_{SNUB} + R_L)$, a very small loss when used with high impedance loads, such as ADCs. For other loads, alternate values of R_{SNUB} can be determined empirically. The data for the curves in the Typical Performance Characteristics section are derived using a $20\ \Omega$ snubbing resistor.

The best way to avoid the effects of stray capacitance is to exercise care in the PCB layout. Locate the passive components or devices connected to the AD8337 output pins as close as possible to the package.

Although a nonissue, the preamplifier output is also sensitive to load capacitance. However, the series connection of R_{FB1} and R_{FB2} is typically the only load connected to the preamplifier. If overshoot appears, it can be mitigated by inserting a snubbing resistor, the same way as the VGA output.

GAIN CONTROL CONSIDERATIONS

In typical applications, voltages applied to the GAIN input are dc or relatively low frequency signals. The high input impedance of the AD8337 enables several devices to be connected in parallel. This is useful for arrays of VGAs, such as those used for calibration adjustments.

Under dc or slowly changing ramp conditions, the gain tracks the gain control voltage, as shown in Figure 3. However, it is often necessary to consider other effects influenced by the V_{GAIN} input.

The offset voltage effect of the AD8337, as with all VGAs, can appear as a complex waveform when observed across the range of V_{GAIN} voltage. Generated by multiple sources, each device has a unique offset voltage (V_{OS}) profile while the GAIN input is swept through its voltage range. The offset voltage profile seen in Figure 15 is a typical example. If the V_{GAIN} input voltage is modulated, the output is the product of the V_{GAIN} and the dc profile of the offset voltage. This is observed on a scope as a small ac signal, as shown in Figure 74. In Figure 74, the signal applied to the V_{GAIN} input is a 1 kHz ramp, and the output voltage signal is slightly less than 4 mV p-p.

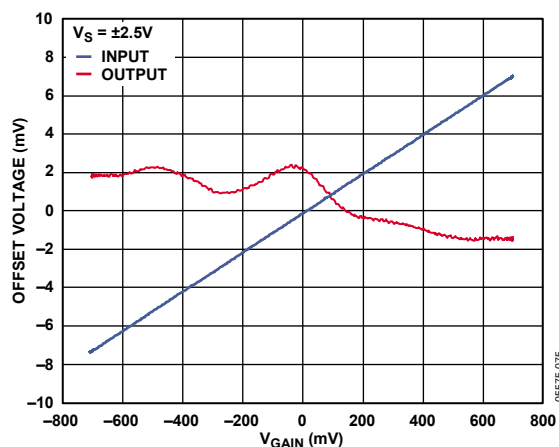


Figure 74. Offset Voltage vs. V_{GAIN} for a 1 kHz Ramp

The profile of the waveform shown in Figure 74 is consistent over a wide range of signals from dc to about 20 kHz. Above 20 kHz, secondary artifacts can be generated due to the effects of minor internal circuit tolerances, as shown in Figure 75. These artifacts are caused by settling and time constants of the interpolator circuit and appear at the output as the voltage spikes, as shown in Figure 75.

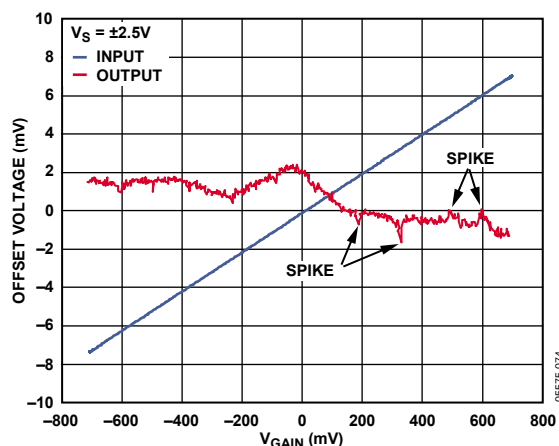


Figure 75. V_{OS} Profile for a 50 kHz Ramp

Under certain circumstances, the product of V_{GAIN} and the offset profile plus spikes is a coherent spurious signal within the signal band of interest and indistinguishable from desired signals. In general, the slower the ramp applied to the GAIN Pin, the smaller the spikes are. In most applications, these effects are benign and not an issue.

THERMAL CONSIDERATIONS

The thermal performance of LFCSPs, such as the AD8337, departs significantly from that of leaded devices such as the larger TSSOP or QFSP. In larger packages, heat is conducted away from the die by the path provided by the bond wires and the device leads. In LFCSPs, the heat transfer mechanisms are surface-to-air radiation from the top and side surfaces of the package and conduction through the metal solder pad on the mounting surface of the device.

θ_{JC} is the traditional thermal metric used for integrated circuits. Heat transfer away from the die is a three-dimensional dynamic, and the path is through the bond wires, leads, and the six surfaces of the package. Because of the small size of LFCSPs, the θ_{JC} is not measured conventionally. Instead, it is calculated using thermodynamic rules.

The θ_{JC} value of the AD8837 listed in Table 2 assumes that the tab is soldered to the board and that there are three additional ground layers beneath the device connected by at least four vias. For a device with an unsoldered pad, the θ_{JC} nearly doubles, becoming 138°C/W.

PSI (Ψ)

Table 2 lists a subset of the classic theta specification, Ψ_{JT} (Psi junction to top). θ_{JC} is the metric of heat transfer from the die to the case, involving the six outside surfaces of the package. $\Psi_{\text{(XY)}}$ is a subset of the theta value and the thermal gradient from the junction (die) to each of the six surfaces. Ψ can be different for each of the surfaces, but since the top of the package is a fraction of a millimeter from the die, the surface temperature of the package is very close to the die temperature. The die temperature is calculated as the product of the power dissipation and Ψ_{JT} . Since the top surface temperature and power dissipation are easily measured, it follows that the die temperature is easily calculated. For example, for a dissipation of 180 mW and a Ψ_{JT} of 5.3°C/W, the die temperature is slightly less than 1°C higher than the surface temperature.

BOARD LAYOUT

Because the AD8337 is a high frequency device, board layout is critical. It is very important to have a good ground plane connection to the VCOM pin. Coupling through the ground plane, from the output to the input, can cause peaking at higher frequencies.

EVALUATION BOARDS

The AD8337 evaluation boards provide a family of platforms for testing and evaluating the AD8337 VGA. Three circuit configurations are available:

- AD8337-EVALZ, dc-coupled, with noninverting gain and dual power supplies
- AD8337-EVALZ-INV, dc-coupled, with inverting gain and dual power supplies
- AD8337-EVALZ-SS, ac-coupled, with noninverting gain configuration and a single supply

These fully assembled and tested boards are ready to use. Only the appropriate power supply and signal source connections need to be made. SMA connectors are provided for the preamplifier (PrA) and VGA outputs. Photos of fully assembled boards are shown in Figure 76 and Figure 77. The board component side layouts are shown in Figure 78 and Figure 79.

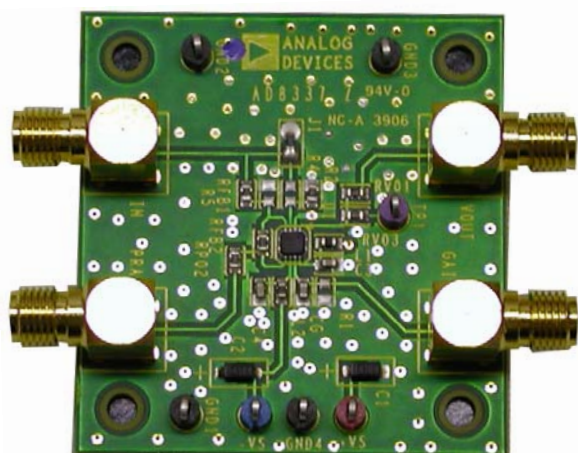


Figure 76. AD8337 Evaluation Board for dual Supplies

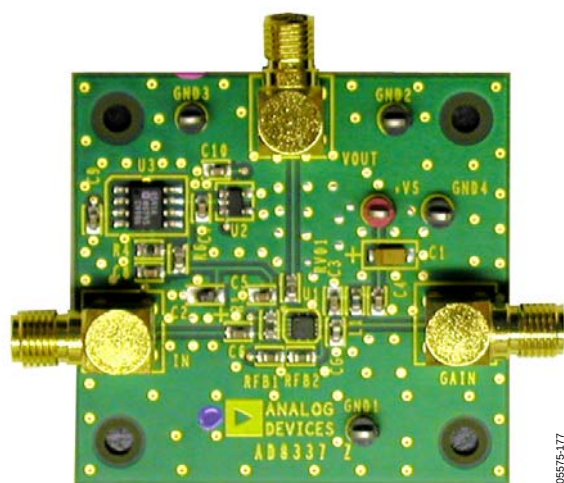


Figure 77. AD8337 Evaluation Board for Single Supply

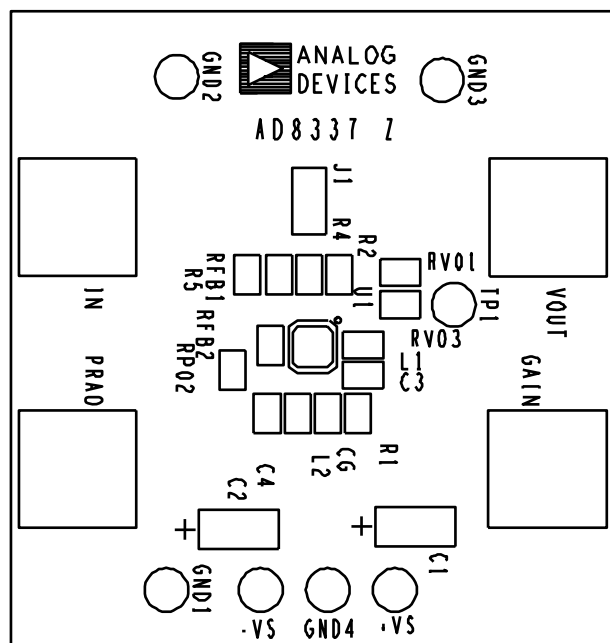


Figure 78. Assembly, Dual-Supply Evaluation Board

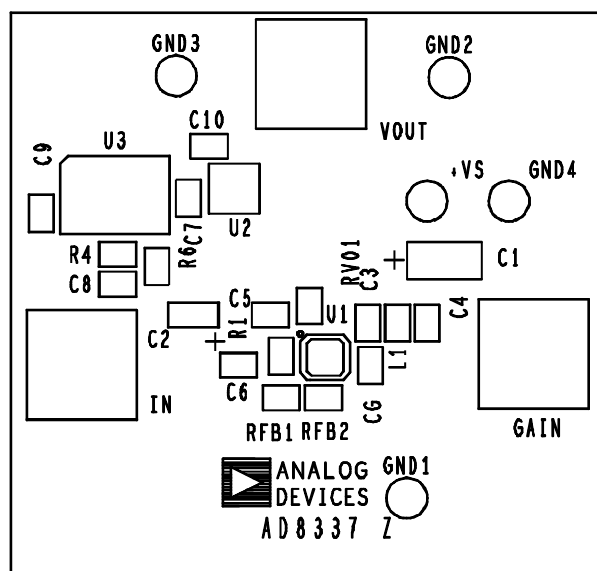


Figure 79. Assembly, Single-Supply Evaluation Board

Schematic diagrams of the dual-supply board for noninverting and inverting configurations are shown in Figure 80 and Figure 81. The dual-supply boards require ± 2.5 V to ± 5 V supplies capable of supplying 20 mA or greater. A schematic diagram of the single-supply board is shown in Figure 82. The single supply version accepts a +5 V to +10 V supply with 20 mA or greater capability.

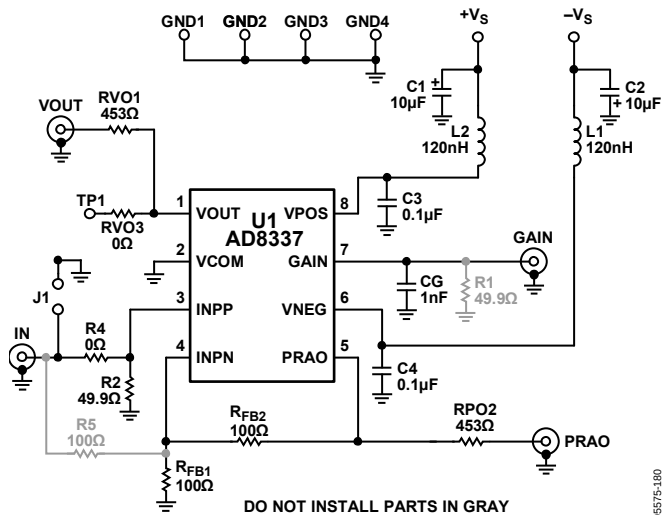


Figure 80. Schematic—AD8337-EVALZ- Noninverting Configuration

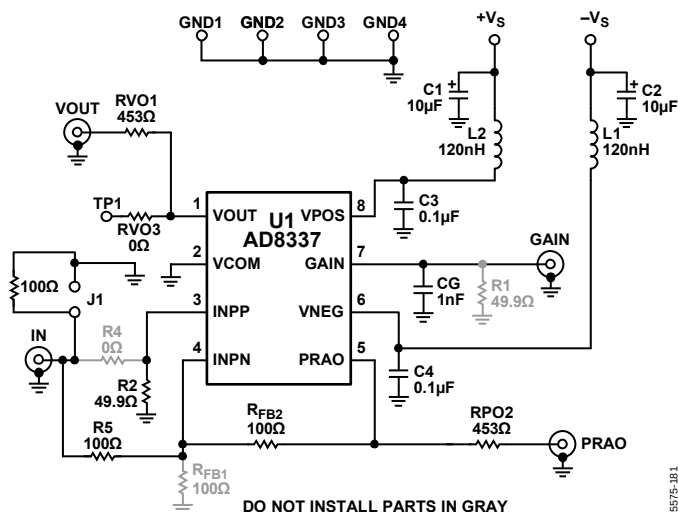


Figure 81. Schematic—AD8337-EVALZ-INV Inverting Configuration

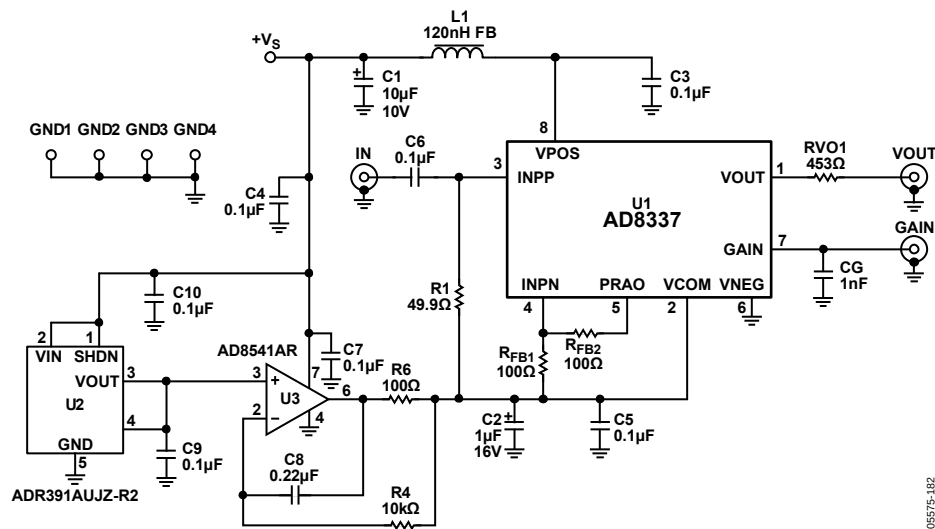


Figure 82. Evaluation Board Schematic—Single-Supply Version

CIRCUIT OPTIONS

Part numbers for fully assembled boards are listed in Table 4.

Table 4. AD8337 Evaluation Board Variations

Part Number	Configuration
AD8337-EVALZ	Dual-supply noninverting
AD8337-EVALZ-INV	Dual-supply inverting
AD8337-EVALZ-SS	Single-supply noninverting

Figure 80, Figure 81, and Figure 82 are schematics for the various circuit configurations. Within limits, the AD8337 preamplifier gain is controlled by Resistor R_{FB1} and Resistor R_{FB2} . For simple guidelines applying to the current-feedback preamplifier, see the Theory of Operation section.

OUTPUT PROTECTION

The AD8337 VGA output stage is specified for driving loads of 500 Ω or greater. To protect the stage from an accidental overload, a 453 Ω resistor is provided, which when connected to 50 Ω test equipment inputs, enables safe operation. In certain high load impedance situations, the value of this resistor can be reduced. However, if load capacitance values greater than approximately 20 pF are anticipated, such as a BNC cable, the minimum series resistor value is not to be less than 20 Ω .

An alternate test pin is also provided for direct access to the output of the AD8337 VGA. The pin is typically used for a probe, and a 0 Ω resistor is provided between the test loop and the output pin. If the test loop is connected to loads $\leq 500 \Omega$, then the 0 Ω resistor is to be changed to an appropriate value.

TOP:
SIGNAL GENERATOR 10.05MHz, 500mV p-p

BOTTOM:
SIGNAL GENERATOR 9.95MHz, 500mV p-p

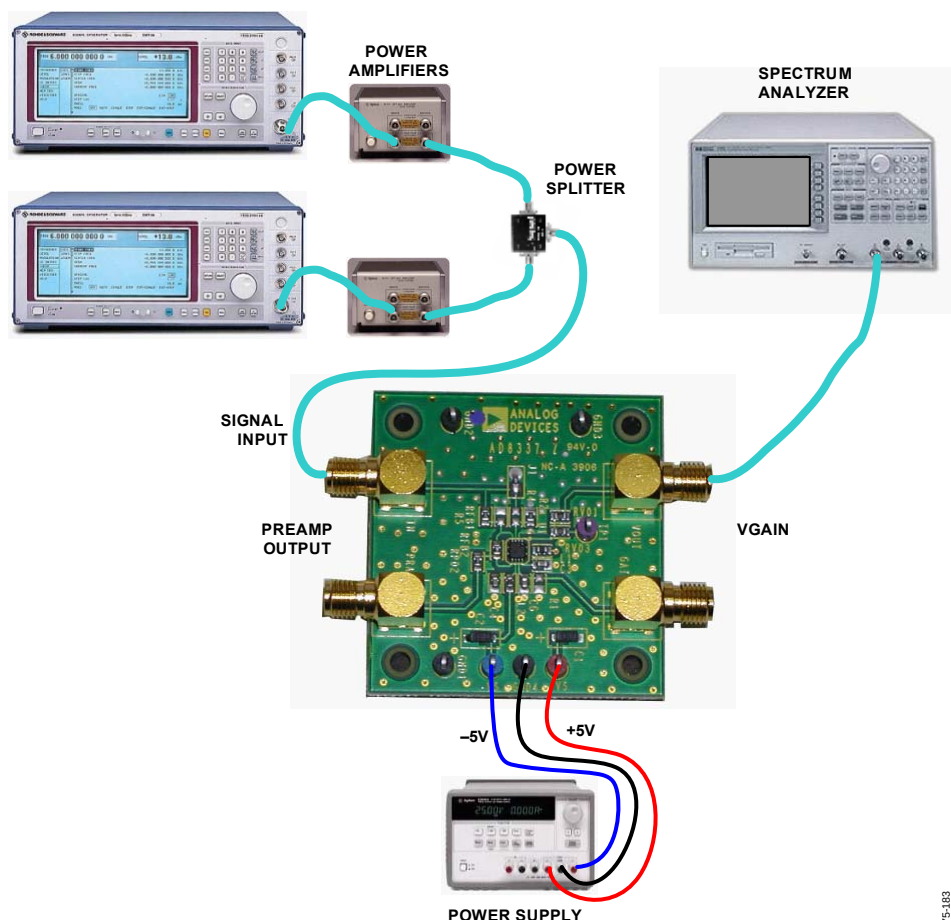


Figure 83. Typical Board Test Connections

MEASUREMENT SETUP

Figure 83 shows board connections for two generators. In this example, the experiment illustrates IMD measurements using standard off-the-shelf test equipment used by Analog Devices. However, any equivalent equipment can be used.

BOARD LAYOUT CONSIDERATIONS

The AD8337 evaluation board is designed using four layers. Interconnecting circuitry is located on the component and wiring sides, with the inner layers dedicated to power and ground planes. Figure 84 through Figure 88 show the copper layouts.

For ease of assembly, all board components are located on the primary side and are 0603 size surface mounts. Higher density applications may require components on both sides of the board and present no problem to the AD8337, as demonstrated in unreleased versions of the board that featured secondary-side components and vias. Not evident in the figures are thermal vias within the pad that solder to the mating pad of the AD8337 chip-scale package. These vias serve as a thermal path and are the primary means of removing heat from the device. The thermal specifications for the AD8337 are predicated on the use of multi-layer board construction with these thermal vias to enable heat conductivity from the die.

05575-183

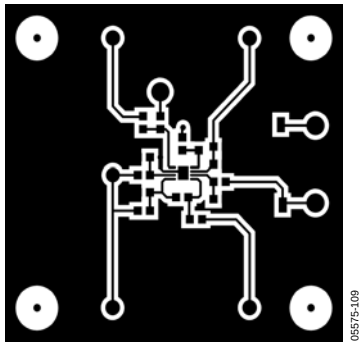


Figure 84. Dual-Supply Component Side Copper

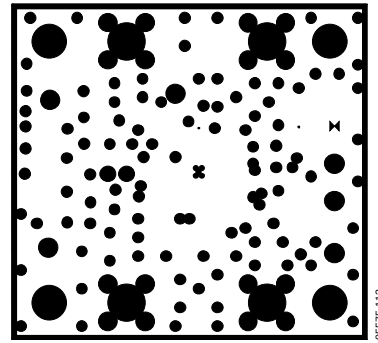


Figure 88. Dual-Supply Power Plane

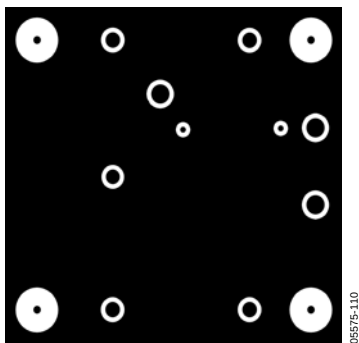


Figure 85. Dual-Supply Wiring Side Copper

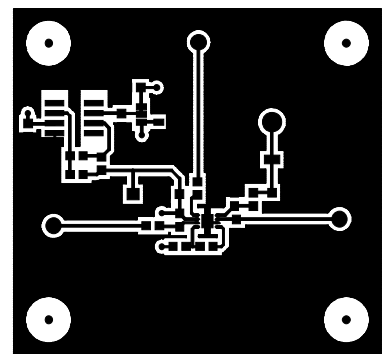


Figure 89. Single-Supply Component Side Copper

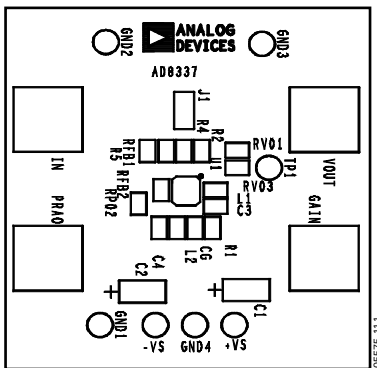


Figure 86. Dual-Supply Component Side Silk-Screen

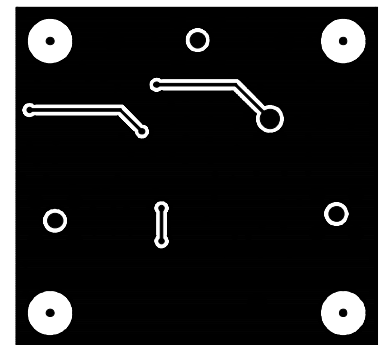


Figure 90. Single-Supply Wiring Side Copper

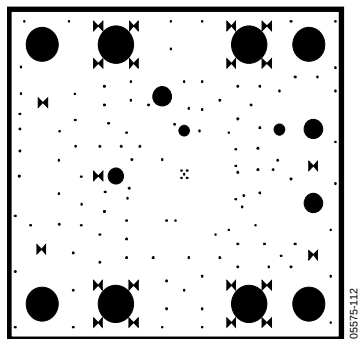


Figure 87. Dual-Supply Ground Plane

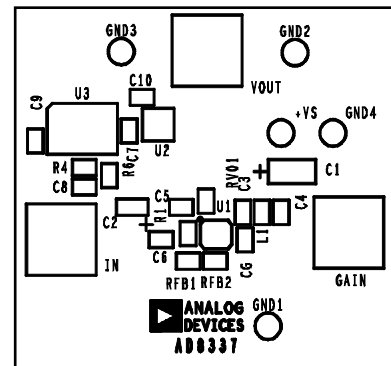


Figure 91. Single-Supply Component Side Silkscreen

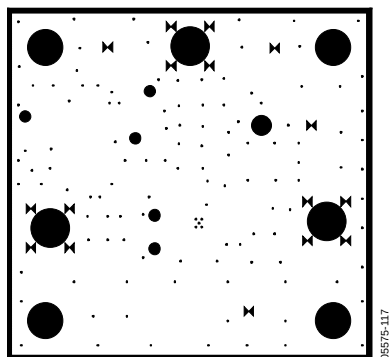


Figure 92. Single-Supply Ground Plane

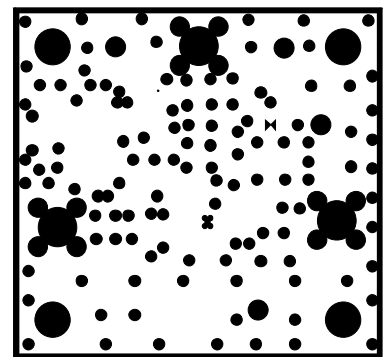


Figure 93. Single-Supply Power Plane

BILL OF MATERIALS

Table 5. Dual-Supply Noninverting Bill of Materials

Qty.	Reference Designator	Description	Manufacturer	Mfg. Part Number
1	+V _S	Red test loop, 0.125" diameter	Bisco Industries	TP-104-01-02
4	GND1 to GND4	Black test loop, 0.125" diameter	Bisco Industries	TP-104-01-00
1	–V _S	Blue test loop, 0.125" diameter	Bisco Industries	TP-104-01-06
1	TP1	Purple test loop, 0.125" diameter	Bisco Industries	TP-104-01-07
2	C3, C4	SM 0.1 μ F, 16 V, 0603, X7R capacitors	KEMET	C0603C104K4RACTU
1	CG	SM 1 nF, 50 V, X7R, 10%, 0603 capacitor	Panasonic	ECJ-1VB2A102K
2	C1, C2	SM tantalum, 10 μ F, 10 V, A size capacitors	Nichicon	T491A106M010AS
1	U1	Integrated circuit VGA	Analog Devices, Inc.	AD8337BCPZ-WP
4	GAIN, IN, PRAO, VOUT	SMA fem PC mount RA connectors	Amphenol	901-143-6RFX
2	L1, L2	120 nH, 0603 ferrite beads	Murata	BLM18BA750SN1D
1	R2	49.9 Ω , 1%, 1/16 W, 0603 resistor	Panasonic	ERJ-3EKF49R9V
2	R4, RVO3	0 Ω , 5%, 1/10 W, 0603 resistors	Panasonic	ERJ-2GE0R00X
2	R _{FB1} , R _{FB2}	100 Ω , 1%, 1/16 W, 0603 resistors	Panasonic	ERJ-3EKF1000V
2	RPO2, RVO1	453 Ω , 1/16 W, 1%, 0603 resistors	Panasonic	ERJ-3EKF4530V

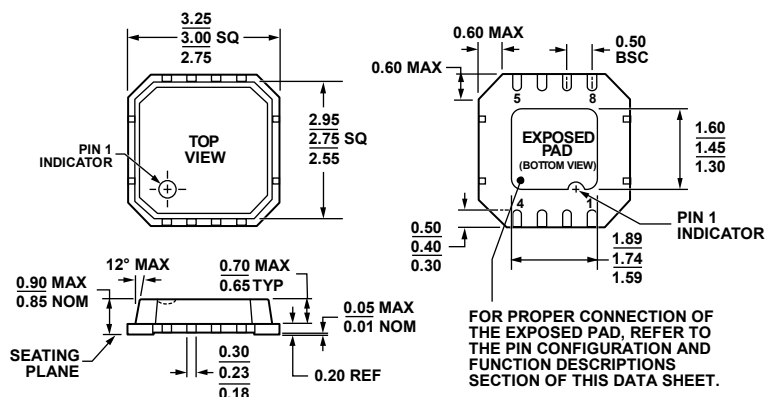
Table 6. Dual-Supply Inverting Gain Bill of Materials

Qty.	Reference Designator	Description	Manufacturer	Mfg. Part Number
1	+V _S	Red test loop, 0.125" diameter	Bisco Industries	TP-104-01-02
4	GND1 to GND4	Black test loop, 0.125" diameter	Bisco Industries	TP-104-01-00
1	–V _S	Blue test loop, 0.125" diameter	Bisco Industries	TP-104-01-06
1	TP1	Purple test loop, 0.125" diameter	Bisco Industries	TP-104-01-07
2	C3, C4	SM 0.1 μ F, 16 V, 0603, X7R capacitors	KEMET	C0603C104K4RACTU
1	CG	SM 1 nF, 50 V, X7R, 10%, 0603 capacitor	Panasonic	ECJ-1VB2A102K
2	C1, C2	SM tantalum, 10 μ F, 10 V, A size capacitors	Nichicon	T491A106M010AS
1	U1	Integrated circuit VGA	Analog Devices, Inc.	AD8337BCPZ-WP
4	GAIN, IN, PRAO, VOUT	SMA fem PC mount RA connectors	Amphenol	901-143-6RFX
2	L1, L2	120 nH, 0603 ferrite beads	Murata	BLM18BA750SN1D
1	R2	49.9 Ω , 1%, 1/16 W, 0603 resistor	Panasonic	ERJ-3EKF49R9V
1	RVO3	0 Ω , 5%, 1/10 W, 0603 resistor	Panasonic	ERJ-2GE0R00X
3	R _{FB2} , R5, J1 (J1 POSITION)	100 Ω , 1%, 1/16 W, 0603 resistors	Panasonic	ERJ-3EKF1000V
2	RPO2, RVO1	453 Ω , 1/16 W, 1%, 0603 resistors	Panasonic	ERJ-3EKF4530V

Table 7. Single-Supply Bill of Materials

Qty.	Reference Designator	Description	Manufacturer	Mfg. Part Number
1	+V _S	Red test point, 0.125" diameter	Bisco Industries	TP-104-01-02
1	C1	Tantalum, 10 μ F, 10 V, A size capacitor	Nichicon	T491A106M010AS
1	C2	Tantalum, 1 μ F, P size capacitor	Nichicon	F921C105MPA
7	C3, C4, C5, C6, C7, C9, C10	0.1 μ F, 16 V, 0603, X7R capacitors	KEMET	C0603C104K4RACTU
1	C8	0.22 μ F, 10%, 0603, X7R capacitor	Panasonic	ECJ-1VB1H223K
1	CG	1 nF, 50 V, X7R, 10%, 0603 capacitor	Panasonic	ECJ-1VB2A102K
3	GAIN, IN, VOUT	SMA fem PC mount RA connectors	Amphenol	901-143-6RFX
4	GND1 to GND4	Loop, 0.125" diameter, black test points	Bisco Industries	TP-104-01-00
1	L1	120 nH, 0603 ferrite bead	Murata	BLM18BA750SN1D
1	R1	49.9 Ω , 1%, 1/16 W, 0603 resistor	Panasonic	ERJ-3EKF49R9V
1	R4	10 k Ω , 1%, 1/16 W, 0603 resistor	Panasonic	ERJ-3EKF1002V
3	R _{FB1} , R _{FB2} , R6	100 Ω , 1%, 1/16 W, 0603 resistors	Panasonic	ERJ-3EKF1000V
1	RVO1	453 Ω , 1%, 1/16 W, 0603 resistor	Panasonic	ERJ-3EKF4530V
1	U1	VGA integrated circuit	Analog Devices, Inc.	AD8337BCPZ-WP
1	U2	2.5 V regulator integrated circuit	Analog Devices, Inc.	ADR391AUJZ-R2
1	U3	SS rail-to-rail op amp integrated circuit	Analog Devices, Inc.	AD8541AR

OUTLINE DIMENSIONS



072408-B

Figure 94. 8-Lead Lead Frame Chip Scale Package [LFCSP_VD]
 3 mm × 3 mm Body, Very Thin, Dual Lead
 (CP-8-2)

Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
AD8337BCPZ-R2 ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-2	HVB
AD8337BCPZ-REEL ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-2	HVB
AD8337BCPZ-REEL7 ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-2	HVB
AD8337BCPZ-WP ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-2	HVB
AD8337-EVALZ ¹		Evaluation Board with Noninverting Gain Configuration		
AD8337-EVALZ-INV ¹		Evaluation Board with Inverting Gain Configuration		
AD8337-EVALZ-SS ¹		Evaluation Board with Single-Supply Operation		

¹ Z = RoHS Compliant Part.

AD8337

NOTES

NOTES

AD8337

NOTES

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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
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- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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